# **PCA9957**

# 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

Rev. 2.1 — 22 October 2021

Product data sheet

# 1 General description

The PCA9957 is a daisy-chain SPI-compatible 4-wire serial bus controlled 24-channel constant current LED driver optimized for dimming and blinking 32 mA Red/Green/Blue/Amber (RGBA) LEDs.

Each LED output has its own 8-bit resolution (256 steps) fixed frequency individual PWM controller that operates at 31.25 kHz with a duty cycle that is adjustable from 0 % to 100 % to allow the LED to be set to a specific brightness value. An additional 8-bit resolution (256 steps) group PWM controller has both a fixed frequency of 122 Hz and an adjustable frequency between 15 Hz to once every 16.8 seconds with a duty cycle that is adjustable from 0 % to 99.6 % that is used to either dim or blink all LEDs with the same value.

Each LED output can be off, on (no PWM control), set at its individual PWM controller value or at both individual and group PWM controller values. The PCA9957 operates with a supply voltage range of 2.7 V to 5.5 V and the constant current sink LED outputs allow up to 5 V for the LED supply. The output peak current is adjustable with an 8-bit linear DAC from 125  $\mu$ A to 31.875 mA with REXT = 2 k $\Omega$ .

Gradation control for all current sources is achieved via the 4-wire serial bus interface and allows user to ramp current automatically without MCU intervention. 8-bit DACs are available to adjust brightness levels for each LED current source. There are six selectable gradation control groups and each group has four independent registers to control ramp-up and ramp-down rate, step time, hold ON/OFF time and final hold ON output current. Two gradation operation modes are available for each group: single shot mode (output pattern once) and continuous mode (output pattern repeat). Each channel can be set to either gradation mode or normal mode and assigned to any one of these six gradation control groups.

This device has built-in open, short load and overtemperature detection circuitry. The error information from the corresponding register can be read via the 4-wire serial bus. Additionally, a thermal shutdown feature protects the device when internal junction temperature exceeds the limit allowed for the process.

The PCA9957 device is designed to use 4-wire read/write serial bus with higher data clock frequency (up to 10 MHz).

The active LOW output enable input pin  $(\overline{OE})$  blinks all the LED outputs and can be used to externally PWM the outputs, which is useful when multiple devices need to be dimmed or blinked together without using software control.



#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# 2 Features and benefits

- 24 LED drivers. Each output programmable at:
  - Off
  - On
  - 8 bits programmable LED brightness
  - 8 bits programmable group dimming/blinking mixed with individual LED brightness
  - Programmable LED output delay to reduce EMI and surge currents
- · Gradation control for all channels
  - Each channel can be assigned to one of six gradation control groups
  - Programmable gradation time and rate for ramp-up and/or ramp-down operations
  - Programmable step time (6-bit) from 0.5 ms (minimum) to 512 ms (maximum)
  - Programmable hold-on time after ramp-up and hold-off time after ramp-down (3-bit) from 0 s to 6 s
  - Programmable final ramp-up and hold-on current
  - Programmable brightness current output adjustment, either linear or exponential curve
- 24 constant current output channels can sink up to 32 mA, and tolerate up to 5.5 V when OFF
- · Output current adjusted through an external resistor (REXT input)
- · Output current accuracy
  - ±6.5 % absolute accuracy with 30 mA output current
  - Maximum ±4 % channel to channel variation
  - Maximum ±6 % device to device variation
- Open/short load/overtemperature detection mode to detect individual LED errors
- 4-wire serial bus interface with 10 MHz data clock rate
- 256-step (8-bit) linear programmable brightness per LED output varying from fully off (default) to maximum brightness fully ON using a 31.25 kHz PWM signal
- 256-step group brightness control allows general dimming (using a 122 Hz PWM signal) from fully off to maximum brightness (default)
- 256-step group blinking with frequency programmable from 15 Hz to 16.8 s and duty cycle from 0 % to 99.6 %
- Active LOW Output Enable (OE) input pin allows for hardware blinking and dimming of the LEDs
- 8 MHz internal oscillator requires no external components
- · Internal power-on reset
- No glitch on LEDn outputs on power-up
- Low standby current
- Operating power supply voltage (V<sub>DD</sub>) range of 2.7 V to 5.5 V
- 5.5 V tolerant inputs on non-LED pins
- -40 °C to +85 °C operation
- Latch-up performance exceeds 100 mA per JESD 78, Class II
- ESD protection exceeds per JESD22:
  - 2 kV Human-Body Model (A114-A)
  - 1 kV Charged-Device Model (C101)
- Package offered: HVQFN40

# 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# 3 Applications

- RGB or RGBA LED drivers
- LED status information
- LED displays
- · LCD backlights
- Keypad backlights for cellular phones or handheld devices
- Fade-in and fade-out for breathlight control

# 4 Ordering information

Table 1. Ordering information

Type number	Topside mark	Package					
		Name	Description	Version			
PCA9957HN	P9957	HVQFN40	Plastic thermal enhanced very thin quad flat package; no leads; 40 terminals; body 5 x 5 x 0.85 mm	SOT1369-5			

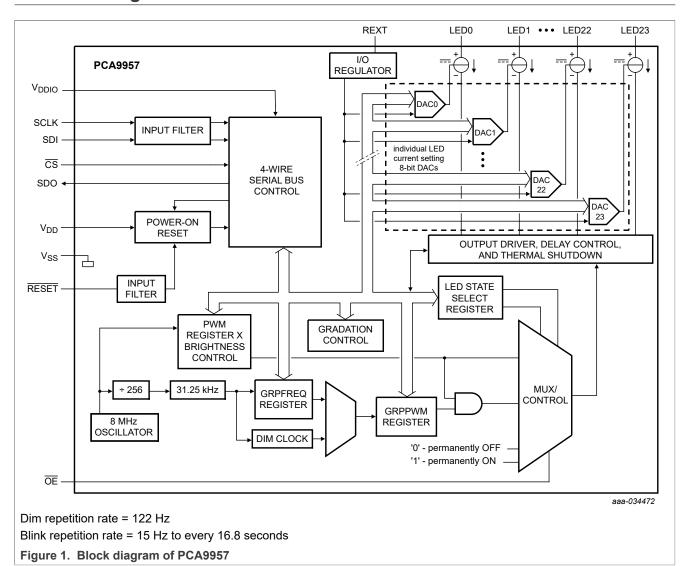
# 4.1 Ordering options

Table 2. Ordering options

Type number	Orderable part number	Package	Packing method	Minimum order quantity	Temperature
PCA9957HN	PCA9957HNMP	HVQFN40	Reel 13" Q2/T3 DP	6000	T <sub>amb</sub> = -40 °C to +85 °C

# 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# 5 Block diagram

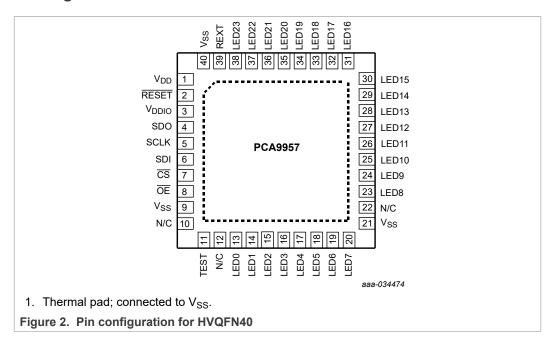


PCA9957

24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# 6 Pinning information

# 6.1 Pinning



# 6.2 Pin description

Table 3. Pin description

Symbol	Pin	Туре	Description
REXT	39	I	current set resistor input; resistor to ground
SDO	4	0	serial data output
CS	7	I	active LOW chip select - when held HIGH the SDO pin is held LOW
ŌĒ	8	I	active LOW output enable for LEDs
LED0	13	0	LED driver 0
LED1	14	0	LED driver 1
LED2	15	0	LED driver 2
LED3	16	0	LED driver 3
LED4	17	0	LED driver 4
LED5	18	0	LED driver 5
LED6	19	0	LED driver 6
LED7	20	0	LED driver 7
LED8	23	0	LED driver 8
LED9	24	0	LED driver 9
LED10	25	0	LED driver 10
LED11	26	0	LED driver 11

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

Table 3. Pin description...continued

Symbol	Pin	Туре	Description
LED12	27	0	LED driver 12
LED13	28	0	LED driver 13
LED14	29	0	LED driver 14
LED15	30	0	LED driver 15
LED16	31	0	LED driver 16
LED17	32	0	LED driver 17
LED18	33	0	LED driver 18
LED19	34	0	LED driver 19
LED20	35	0	LED driver 20
LED21	36	0	LED driver 21
LED22	37	0	LED driver 22
LED23	38	0	LED driver 23
RESET	2	I	active LOW reset input with external 10 $k\Omega$ pull-up resistor
SCLK	5	I	serial clock line
SDI	6	I	serial data input
V <sub>SS</sub>	9, 21, 40 <sup>[1]</sup>	ground	supply ground
$V_{DDIO}$	3	power supply	supply rail of SPI interface
$V_{DD}$	1	power supply	supply voltage
N/C	10, 12, 22	N/A	no connection
TEST	11	factory test	internal pull down - connect to GND or leave floating

<sup>[1]</sup> HVQFN40 package supply ground is connected to both V<sub>SS</sub> pins and exposed center pad. V<sub>SS</sub> pins must be connected to supply ground for proper device operation. For enhanced thermal, electrical, and board level performance, the exposed pad needs to be soldered to the board using a corresponding thermal pad on the board and for proper heat conduction through the board, thermal vias need to be incorporated in the printed-circuit board in the thermal pad region.

# 7 Functional description

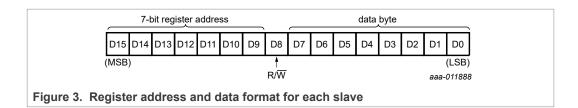
Refer to Figure 1.

# 7.1 Register address and data

Following a chip select  $(\overline{CS})$  asserted condition (from HIGH to LOW), the data transfers are (16 × n) bits wide (where 'n' is the number of slaves in the chain) with MSB transferred first. The first 7 bits are the address of the register to be accessed. The eighth bit indicates the types of access — read (= 1) or write (= 0). The second group of 8 bits consists of data as shown in Figure 3.

See Section 8 for more detail.

# 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver



# 7.2 Register definitions

Table 4. Register summary - default values

Register # (hex)	D7	D6	D5	D4	D3	D2	D1	D0	Name	Туре	Function
00h	0	0	0	0	0	0	0	0	MODE1	read/write	Mode register 1
01h	0	0	0	0	0	0	0	1	MODE2	read/write	Mode register 2
02h	0	0	0	0	0	0	0	0	EFLAG0	read only	output error flag 0
03h	0	0	0	0	0	0	0	0	EFLAG1	read only	output error flag 1
04h	0	0	0	0	0	0	0	0	EFLAG2	read only	output error flag 2
05h	0	0	0	0	0	0	0	0	EFLAG3	read only	output error flag 3
06h	0	0	0	0	0	0	0	0	EFLAG4	read only	output error flag 4
07h	0	0	0	0	0	0	0	0	EFLAG5	read only	output error flag 5
08h	1	0	1	0	1	0	1	0	LEDOUT0	read/write	LED output state 0
09h	1	0	1	0	1	0	1	0	LEDOUT1	read/write	LED output state 1
0Ah	1	0	1	0	1	0	1	0	LEDOUT2	read/write	LED output state 2
0Bh	1	0	1	0	1	0	1	0	LEDOUT3	read/write	LED output state 3
0Ch	1	0	1	0	1	0	1	0	LEDOUT4	read/write	LED output state 4
0Dh	1	0	1	0	1	0	1	0	LEDOUT5	read/write	LED output state 5
0Eh	1	1	1	1	1	1	1	1	GRPPWM	read/write	group duty cycle control
0Fh	0	0	0	0	0	0	0	0	GRPFREQ	read/write	group frequency
10h	0	0	0	0	0	0	0	0	PWM0	read/write	brightness control LED0
11h	0	0	0	0	0	0	0	0	PWM1	read/write	brightness control LED1
12h	0	0	0	0	0	0	0	0	PWM2	read/write	brightness control LED2
13h	0	0	0	0	0	0	0	0	PWM3	read/write	brightness control LED3
14h	0	0	0	0	0	0	0	0	PWM4	read/write	brightness control LED4
15h	0	0	0	0	0	0	0	0	PWM5	read/write	brightness control LED5
16h	0	0	0	0	0	0	0	0	PWM6	read/write	brightness control LED6
17h	0	0	0	0	0	0	0	0	PWM7	read/write	brightness control LED7
18h	0	0	0	0	0	0	0	0	PWM8	read/write	brightness control LED8
19h	0	0	0	0	0	0	0	0	PWM9	read/write	brightness control LED9
1Ah	0	0	0	0	0	0	0	0	PWM10	read/write	brightness control LED10
1Bh	0	0	0	0	0	0	0	0	PWM11	read/write	brightness control LED11
1Ch	0	0	0	0	0	0	0	0	PWM12	read/write	brightness control LED12

# 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

Table 4. Register summary - default values...continued

Table 4. Ro							1	1			
Register # (hex)	D7	D6	D5	D4	D3	D2	D1	D0	Name	Туре	Function
1Dh	0	0	0	0	0	0	0	0	PWM13	read/write	brightness control LED13
1Eh	0	0	0	0	0	0	0	0	PWM14	read/write	brightness control LED14
1Fh	0	0	0	0	0	0	0	0	PWM15	read/write	brightness control LED15
20h	0	0	0	0	0	0	0	0	PWM16	read/write	brightness control LED16
21h	0	0	0	0	0	0	0	0	PWM17	read/write	brightness control LED17
22h	0	0	0	0	0	0	0	0	PWM18	read/write	brightness control LED18
23h	0	0	0	0	0	0	0	0	PWM19	read/write	brightness control LED19
24h	0	0	0	0	0	0	0	0	PWM20	read/write	brightness control LED20
25h	0	0	0	0	0	0	0	0	PWM21	read/write	brightness control LED21
26h	0	0	0	0	0	0	0	0	PWM22	read/write	brightness control LED22
27h	0	0	0	0	0	0	0	0	PWM23	read/write	brightness control LED23
28h	0	0	0	0	0	0	0	0	IREF0	read/write	output gain control register 0
29h	0	0	0	0	0	0	0	0	IREF1	read/write	output gain control register 1
2Ah	0	0	0	0	0	0	0	0	IREF2	read/write	output gain control register 2
2Bh	0	0	0	0	0	0	0	0	IREF3	read/write	output gain control register 3
2Ch	0	0	0	0	0	0	0	0	IREF4	read/write	output gain control register 4
2Dh	0	0	0	0	0	0	0	0	IREF5	read/write	output gain control register 5
2Eh	0	0	0	0	0	0	0	0	IREF6	read/write	output gain control register 6
2Fh	0	0	0	0	0	0	0	0	IREF7	read/write	output gain control register 7
30h	0	0	0	0	0	0	0	0	IREF8	read/write	output gain control register 8
31h	0	0	0	0	0	0	0	0	IREF9	read/write	output gain control register 9
32h	0	0	0	0	0	0	0	0	IREF10	read/write	output gain control register 10
33h	0	0	0	0	0	0	0	0	IREF11	read/write	output gain control register 11
34h	0	0	0	0	0	0	0	0	IREF12	read/write	output gain control register 12
35h	0	0	0	0	0	0	0	0	IREF13	read/write	output gain control register 13
36h	0	0	0	0	0	0	0	0	IREF14	read/write	output gain control register 14
37h	0	0	0	0	0	0	0	0	IREF15	read/write	output gain control register 15
38h	0	0	0	0	0	0	0	0	IREF16	read/write	output gain control register 16
39h	0	0	0	0	0	0	0	0	IREF17	read/write	output gain control register 17
3Ah	0	0	0	0	0	0	0	0	IREF18	read/write	output gain control register 18
3Bh	0	0	0	0	0	0	0	0	IREF19	read/write	output gain control register 19
3Ch	0	0	0	0	0	0	0	0	IREF20	read/write	output gain control register 20
3Dh	0	0	0	0	0	0	0	0	IREF21	read/write	output gain control register 21
3Eh	0	0	0	0	0	0	0	0	IREF22	read/write	output gain control register 22
3Fh	0	0	0	0	0	0	0	0	IREF23	read/write	output gain control register 23
									*	*	

# 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

Table 4. Register summary - default values...continued

Register # (hex)	D7	D6	D5	D4	D3	D2	D1	D0	Name	Туре	Function
40h	0	0	0	0	0	0	0	0	RAMP_RATE_GRP0	read/write	ramp enable and rate control for group 0
41h	0	0	0	0	0	0	0	0	STEP_TIME_GRP0	read/write	step time control for group 0
42h	0	0	0	0	0	0	0	0	HOLD_CNTL_GRP0	read/write	hold ON/OFF time control for group 0
43h	0	0	0	0	0	0	0	0	IREF_GRP0	read/write	output gain control for group 0
44h	0	0	0	0	0	0	0	0	RAMP_RATE_GRP1	read/write	ramp enable and rate control for group 1
45h	0	0	0	0	0	0	0	0	STEP_TIME_GRP1	read/write	step time control for group 1
46h	0	0	0	0	0	0	0	0	HOLD_CNTL_GRP1	read/write	hold ON/OFF time control for group 1
47h	0	0	0	0	0	0	0	0	IREF_GRP1	read/write	output gain control for group 1
48h	0	0	0	0	0	0	0	0	RAMP_RATE_GRP2	read/write	ramp enable and rate control for group 2
49h	0	0	0	0	0	0	0	0	STEP_TIME_GRP2	read/write	step time control for group 2
4Ah	0	0	0	0	0	0	0	0	HOLD_CNTL_GRP2	read/write	hold ON/OFF time control for group 2
4Bh	0	0	0	0	0	0	0	0	IREF_GRP2	read/write	output gain control for group 2
4Ch	0	0	0	0	0	0	0	0	RAMP_RATE_GRP3	read/write	ramp enable and rate control for group 3
4Dh	0	0	0	0	0	0	0	0	STEP_TIME_GRP3	read/write	step time control for group 3
4Eh	0	0	0	0	0	0	0	0	HOLD_CNTL_GRP3	read/write	hold ON/OFF time control for group 3
4Fh	0	0	0	0	0	0	0	0	IREF_GRP3	read/write	output gain control for group 3
50h	0	0	0	0	0	0	0	0	RAMP_RATE_GRP4	read/write	ramp enable and rate control for group 4
51h	0	0	0	0	0	0	0	0	STEP_TIME_GRP4	read/write	step time control for group 4
52h	0	0	0	0	0	0	0	0	HOLD_CNTL_GRP4	read/write	hold ON/OFF time control for group 4
53h	0	0	0	0	0	0	0	0	IREF_GRP4	read/write	output gain control for group 4
54h	0	0	0	0	0	0	0	0	RAMP_RATE_GRP5	read/write	ramp enable and rate control for group 5
55h	0	0	0	0	0	0	0	0	STEP_TIME_GRP5	read/write	step time control for group 5
56h	0	0	0	0	0	0	0	0	HOLD_CNTL_GRP5	read/write	hold ON/OFF time control for group 5
57h	0	0	0	0	0	0	0	0	IREF_GRP5	read/write	output gain control for group 5
58h	0	0	0	0	0	0	0	0	GRAD_MODE_SEL0	read/write	gradation mode select register for channel 7 to channel 0
59h	0	0	0	0	0	0	0	0	GRAD_MODE_SEL1	read/write	gradation mode select register for channel 15 to channel 8

# 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

Table 4. Register summary - default values...continued

Register # (hex)	D7	D6	D5	D4	D3	D2	D1	D0	Name	Туре	Function
5Ah	0	0	0	0	0	0	0	0	GRAD_MODE_SEL2	read/write	gradation mode select register for channel 23 to channel 16
5Bh	0	0	0	0	0	0	0	0	GRAD_GRP_SEL0	read/write	gradation group select for channel 1 to channel 0
5Ch	0	0	0	0	0	0	0	0	GRAD_GRP_SEL1	read/write	gradation group select for channel 3 to channel 2
5Dh	0	0	0	1	0	0	0	1	GRAD_GRP_SEL2	read/write	gradation group select for channel 5 to channel 4
5Eh	0	0	0	1	0	0	0	1	GRAD_GRP_SEL3	read/write	gradation group select for channel 7 to channel 6
5Fh	0	0	1	0	0	0	1	0	GRAD_GRP_SEL4	read/write	gradation group select for channel 9 to channel 8
60h	0	0	1	0	0	0	1	0	GRAD_GRP_SEL5	read/write	gradation group select for channel 11 to channel 10
61h	0	0	1	1	0	0	1	1	GRAD_GRP_SEL6	read/write	gradation group select for channel 13 to channel 12
62h	0	0	1	1	0	0	1	1	GRAD_GRP_SEL7	read/write	gradation group select for channel 15 to channel 14
63h	0	1	0	0	0	1	0	0	GRAD_GRP_SEL8	read/write	gradation group select for channel 17 to channel 16
64h	0	1	0	0	0	1	0	0	GRAD_GRP_SEL9	read/write	gradation group select for channel 19 to channel 18
65h	0	1	0	1	0	1	0	1	GRAD_GRP_SEL10	read/write	gradation group select for channel 21 to channel 20
66h	0	1	0	1	0	1	0	1	GRAD_GRP_SEL11	read/write	gradation group select for channel 23 to channel 22
67h	0	0	0	0	0	0	0	0	GRAD_CNTL0	read/write	gradation control register for group 3 to group 0
68h	0	0	0	0	0	0	0	0	GRAD_CNTL1	read/write	gradation control register for group 5 to group 4
69h	0	0	0	0	1	0	0	0	OFFSET	read/write	Offset/delay on LEDn outputs
6Ah	0	0	0	0	0	0	0	0	PWMALL	write only	brightness control for all LEDn
6Bh	0	0	0	0	0	0	0	0	IREFALL	write only	output gain control for all registers IREF0 to IREF23
6Ch											
to	:	:	:	:	:	:	:	:	reserved <sup>[1]</sup>	read only	not used
7Fh											
			1	1	1	1	1	1	1	I.	

<sup>[1]</sup> Reserved registers should not be written to - default is 0

# 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# 7.2.1 MODE1 — Mode register 1

Table 5. MODE1 - Mode register 1 (address 00h) bit description Legend: \* default value.

Bit	Symbol	Access	Value	Description		
7	-	read only	0*	reserved		
6	-	R/W	0* reserved			
5	-	R/W	0*	reserved		
4	SLEEP	R/W	0*	Normal mode <sup>[1]</sup> .		
			1	Low-power mode. Oscillator off <sup>[2][3]</sup> .		
3	-	R/W	0*	reserved		
2	-	R/W	0*	reserved		
1	-	R/W	0*	reserved		
0	-	R/W	0*	reserved		

<sup>[1]</sup> It takes 500 µs max. for the oscillator to be up and running once SLEEP bit has been set to logic 0. Timings on LEDn outputs are not guaranteed if PWMx, GRPPWM or GRPFREQ registers are accessed within the 500 µs window.

# 7.2.2 MODE2 — Mode register 2

Table 6. MODE2 - Mode register 2 (address 01h) bit description Legend: \* default value.

Bit	Symbol	Access	Value	Description
7	OVERTEMP	read only	0*	O.K.
			1	overtemperature condition
6	ERROR	read only	0*	no error at LED outputs
			1	any open or short-circuit detected in error flag registers (EFLAGn)
5	DMBLNK	R/W	0*	group control = dimming
			1	group control = blinking
4	CLRERR	write only	0*	self clear after write '1'
			1	Write '1' to clear all error status bits in EFLAGn register and ERROR (bit 6). The EFLAGn and ERROR bit will set to '1' if open or short-circuit is detected again.
3	AUTO_ SWITCHOFF_ DIS	R/W	0*	Disable the channel for which open or short error is detected and enable it again when write 1 to CLRERR, clears all error status bits in EFLAGn registers and ERROR bit
			1	The channel won't be turned off when open/short detected
2	EXP_EN	R/W	0*	linear adjustment for gradation control
			1	exponential adjustment for gradation control

No blinking, dimming or gradation control is possible when the oscillator is off.

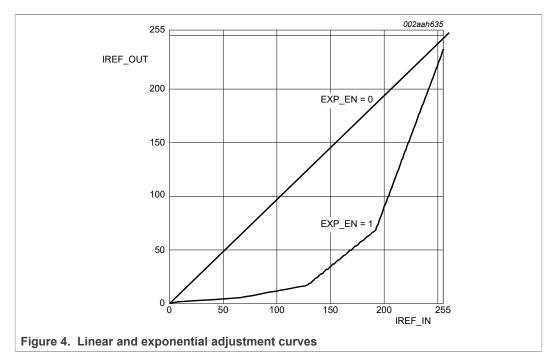
The device must be reset if the LED driver output state is set to LDRx=11 after the device is set back to Normal mode.

# 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

Table 6. MODE2 - Mode register 2 (address 01h) bit description...continued Legend: \* default value.

Bit	Symbol	Access	Value	Description
1	-	read only	0*	reserved
0	-	read only	1*	reserved

Brightness adjustment for gradation control is either linear or exponential by setting the EXP\_EN bit as shown in <u>Figure 4</u>. When EXP\_EN = 0, linear adjustment scale is used. When EXP\_EN = 1, exponential scale is used.



# 7.2.3 LEDOUT0 to LEDOUT5, LED driver output state

Table 7. LEDOUT0 to LEDOUT5 - LED driver output state registers (address 08h to 0Dh) bit description

Address	Register	Bit	Symbol	Access	Value	Description
08h	LEDOUT0	7:6	LDR3	R/W	10*	LED3 output state control
		5:4	LDR2	R/W	10*	LED2 output state control
		3:2	LDR1	R/W	10*	LED1 output state control
		1:0	LDR0	R/W	10*	LED0 output state control
09h	LEDOUT1	7:6	LDR7	R/W	10*	LED7 output state control
		5:4	LDR6	R/W	10*	LED6 output state control
		3:2	LDR5	R/W	10*	LED5 output state control
		1:0	LDR4	R/W	10*	LED4 output state control
0Ah	LEDOUT2	7:6	LDR11	R/W	10*	LED11 output state control

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

Table 7. LEDOUT0 to LEDOUT5 - LED driver output state registers (address 08h to 0Dh) bit description...continued

Legend: \* default value.

Address	Register	Bit	Symbol	Access	Value	Description
		5:4	LDR10	R/W	10*	LED10 output state control
		3:2	LDR9	R/W	10*	LED9 output state control
		1:0	LDR8	R/W	10*	LED8 output state control
0Bh	LEDOUT3	7:6	LDR15	R/W	10*	LED15 output state control
		5:4	LDR14	R/W	10*	LED14 output state control
		3:2	LDR13	R/W	10*	LED13 output state control
		1:0	LDR12	R/W	10*	LED12 output state control
0Ch	LEDOUT4	7:6	LDR19	R/W	10*	LED19 output state control
		5:4	LDR18	R/W	10*	LED18 output state control
		3:2	LDR17	R/W	10*	LED17 output state control
		1:0	LDR16	R/W	10*	LED16 output state control
0Dh	LEDOUT5	7:6	LDR23	R/W	10*	LED23 output state control
		5:4	LDR22	R/W	10*	LED22 output state control
		3:2	LDR21	R/W	10*	LED21 output state control
		1:0	LDR20	R/W	10*	LED20 output state control

#### LDRx = 00

LED driver x is off (x = 0 to 23).

#### LDRx = 01

LED driver x is fully on (individual brightness and group dimming/blinking not controlled). The  $\overline{\text{OE}}$  pin can be used as external dimming/blinking control in this state.

# LDRx = 10

LED driver x individual brightness can be controlled through its PWMx register (default power-up state) or PWMALL register for all LEDn outputs.

#### LDRx = 11

LED driver x individual brightness and group dimming/blinking can be controlled through its PWMx register and the GRPPWM registers.

**Remark:** Setting the device in low power mode while being on group dimming/blinking mode (LDRx = 11) may cause the LED output state to be in an unknown state after the device is set back to normal mode. The device must be reset and all register values reprogrammed.

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# 7.2.4 GRPPWM, group duty cycle control

Table 8. GRPPWM - Group brightness control register (address 0Eh) bit description

Legend: \* default value

Address	Register	Bit	Symbol	Access	Value	Description
0Eh	GRPPWM	7:0	GDC[7:0]	R/W	1111 1111*	GRPPWM register

When DMBLNK bit (MODE2 register) is programmed with logic 0, a 122 Hz fixed frequency signal is superimposed with the 31.25 kHz individual brightness control signal. GRPPWM is then used as a global brightness control allowing the LED outputs to be dimmed with the same value. The value in GRPFREQ is then a 'Don't care'.

General brightness for the 24 outputs is controlled through 255 linear steps from 00h (0 % duty cycle = LED output off) to FFh (99.6 % duty cycle = maximum brightness). Applicable to LED outputs programmed with LDRx = 11 (LEDOUT0 to LEDOUT3 registers).

When DMBLNK bit is programmed with logic 1, GRPPWM and GRPFREQ registers define a global blinking pattern, where GRPFREQ contains the blinking period (from 67 ms to 16.8 s) and GRPPWM the duty cycle (ON/OFF ratio in %).

$$dutycycle = \frac{GDC[7:0]}{256} (1)$$

# 7.2.5 GRPFREQ, group frequency

Table 9. GRPFREQ - Group frequency register (address 0Fh) bit description Legend: \* default value.

Address	Register	Bit	Symbol	Access	Value	Description
0Fh	GRPFREQ	7:0	GFRQ[7:0]	R/W	0000 0000*	GRPFREQ register

GRPFREQ is used to program the global blinking period when DMBLNK bit (MODE2 register) is equal to 1. Value in this register is a 'Don't care' when DMBLNK = 0. Applicable to LED outputs programmed with LDRx = 11 (LEDOUT0 to LEDOUT3 registers).

Blinking period is controlled through 256 linear steps from 00h (67 ms, frequency 15 Hz) to FFh (16.8 s).

$$globalblinkingperiod = \frac{GFRQ[7:0]+1}{15.26} (s) (2)$$

# 7.2.6 PWM0 to PWM23, individual brightness control

Table 10. PWM0 to PWM23 - PWM registers 0 to 23 (address 10h to 27h) bit description

Address	Register	Bit	Symbol	Access	Value	Description
10h	PWM0	7:0	IDC0[7:0]	R/W	0000 0000*	PWM0 Individual Duty Cycle
11h	PWM1	7:0	IDC1[7:0]	R/W	0000 0000*	PWM1 Individual Duty Cycle
12h	PWM2	7:0	IDC2[7:0]	R/W	0000 0000*	PWM2 Individual Duty Cycle

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

Table 10. PWM0 to PWM23 - PWM registers 0 to 23 (address 10h to 27h) bit description...continued

Legend: \* default value.

Address	Register	Bit	Symbol	Access	Value	Description
13h	PWM3	7:0	IDC3[7:0]	R/W	0000 0000*	PWM3 Individual Duty Cycle
14h	PWM4	7:0	IDC4[7:0]	R/W	0000 0000*	PWM4 Individual Duty Cycle
15h	PWM5	7:0	IDC5[7:0]	R/W	0000 0000*	PWM5 Individual Duty Cycle
16h	PWM6	7:0	IDC6[7:0]	R/W	0000 0000*	PWM6 Individual Duty Cycle
17h	PWM7	7:0	IDC7[7:0]	R/W	0000 0000*	PWM7 Individual Duty Cycle
18h	PWM8	7:0	IDC8[7:0]	R/W	0000 0000*	PWM8 Individual Duty Cycle
19h	PWM9	7:0	IDC9[7:0]	R/W	0000 0000*	PWM9 Individual Duty Cycle
1Ah	PWM10	7:0	IDC10[7:0]	R/W	0000 0000*	PWM10 Individual Duty Cycle
1Bh	PWM11	7:0	IDC11[7:0]	R/W	0000 0000*	PWM11 Individual Duty Cycle
1Ch	PWM12	7:0	IDC12[7:0]	R/W	0000 0000*	PWM12 Individual Duty Cycle
1Dh	PWM13	7:0	IDC13[7:0]	R/W	0000 0000*	PWM13 Individual Duty Cycle
1Eh	PWM14	7:0	IDC14[7:0]	R/W	0000 0000*	PWM14 Individual Duty Cycle
1Fh	PWM15	7:0	IDC15[7:0]	R/W	0000 0000*	PWM15 Individual Duty Cycle
20h	PWM16	7:0	IDC8[7:0]	R/W	0000 0000*	PWM16 Individual Duty Cycle
21h	PWM17	7:0	IDC9[7:0]	R/W	0000 0000*	PWM17 Individual Duty Cycle
22h	PWM18	7:0	IDC10[7:0]	R/W	0000 0000*	PWM18 Individual Duty Cycle
23h	PWM19	7:0	IDC11[7:0]	R/W	0000 0000*	PWM19 Individual Duty Cycle
24h	PWM20	7:0	IDC12[7:0]	R/W	0000 0000*	PWM20 Individual Duty Cycle
25h	PWM21	7:0	IDC13[7:0]	R/W	0000 0000*	PWM21 Individual Duty Cycle
26h	PWM22	7:0	IDC14[7:0]	R/W	0000 0000*	PWM22 Individual Duty Cycle
27h	PWM23	7:0	IDC15[7:0]	R/W	0000 0000*	PWM23 Individual Duty Cycle

A 31.25 kHz fixed frequency signal is used for each output. Duty cycle is controlled through 255 linear steps from 00h (0 % duty cycle = LED output off) to FEh (99.2 % duty cycle = LED output at maximum brightness) and FFh (100 % duty cycle = LED output completed ON). Applicable to LED outputs programmed with LDRx = 10 or 11 (LEDOUT0 to LEDOUT3 registers).

$$dutycycle = \frac{IDCx[7:0]}{256} (3)$$

**Remark:** The first lower end 8 steps of PWM and the last (higher end) steps of PWM will not have effective brightness control of LEDs due to edge rate control of LED output pins.

# 7.2.7 IREF0 to IREF23, LED output current value registers

These registers reflect the gain settings for output current for LED0 to LED23.

# 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

Table 11. IREF0 to IREF23 - LED output gain control registers (address 28h to 3Fh) bit description

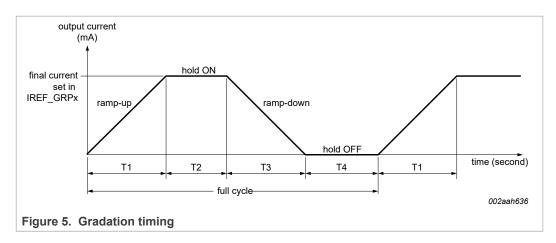
Legend: \* default value.

Address	Register	Bit	Access	Value	Description
28h	IREF0	7:0	R/W	00h*	LED0 output current setting
29h	IREF1	7:0	R/W	00h*	LED1 output current setting
2Ah	IREF2	7:0	R/W	00h*	LED2 output current setting
2Bh	IREF3	7:0	R/W	00h*	LED3 output current setting
2Ch	IREF4	7:0	R/W	00h*	LED4 output current setting
2Dh	IREF5	7:0	R/W	00h*	LED5 output current setting
2Eh	IREF6	7:0	R/W	00h*	LED6 output current setting
2Fh	IREF7	7:0	R/W	00h*	LED7 output current setting
30h	IREF8	7:0	R/W	00h*	LED8 output current setting
31h	IREF9	7:0	R/W	00h*	LED9 output current setting
32h	IREF10	7:0	R/W	00h*	LED10 output current setting
33h	IREF11	7:0	R/W	00h*	LED11 output current setting
34h	IREF12	7:0	R/W	00h*	LED12 output current setting
35h	IREF13	7:0	R/W	00h*	LED13 output current setting
36h	IREF14	7:0	R/W	00h*	LED14 output current setting
37h	IREF15	7:0	R/W	00h*	LED15 output current setting
38h	IREF16	7:0	R/W	00h*	LED16 output current setting
39h	IREF17	7:0	R/W	00h*	LED17 output current setting
3Ah	IREF18	7:0	R/W	00h*	LED18 output current setting
3Bh	IREF19	7:0	R/W	00h*	LED19 output current setting
3Ch	IREF20	7:0	R/W	00h*	LED20 output current setting
3Dh	IREF21	7:0	R/W	00h*	LED21 output current setting
3Eh	IREF22	7:0	R/W	00h*	LED22 output current setting
3Fh	IREF23	7:0	R/W	00h*	LED23 output current setting

#### 7.2.8 Gradation control

Gradation control is designed to use six independent groups of registers to program the full cycle of the gradation timing to implement on each selected channel. Each group has four registers to define the ramp rate, step time, hold ON/OFF time, and final hold ON current, as shown in <u>Figure 5</u>.

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver



- The 'final' and 'hold ON' current is defined in IREF\_GRPx register value × (125  $\mu$ A if REXT = 2 k $\Omega$ ).
- Ramp rate value and enable/disable ramp operation is defined in RAMP\_RATE\_GRPx register.
- Total number of ramp steps (or level changes) is calculated as 'IREF\_GRPx value' ÷
   ramp rate value in RAMP\_RATE\_GRPx'. Rounds a number up to the next integer if the
   total number is not an integer.
- Time for each step is calculated as 'cycle time' × 'multiple factor' bits in STEP\_TIME\_GRPx register. Minimum time for one step is 0.5 ms (0.5 ms × 1) and maximum time is 512 ms (8 ms × 64).
- The ramp-up or ramp-down time (T1 or T3) is calculated as '(total steps + 1)' × 'step time'.
- Hold ON or OFF time (T2 or T4) is defined in HOLD\_CNTL\_GRPx register in the range of 0/0.25/0.5/0.75/1/2/4/6 seconds.
- Gradation start or stop with single shot mode (one full cycle only) or continuous mode (repeat full cycle) is defined in the GRAD\_CNTL register for all groups.
- Each channel can be assigned to one of these six groups in the GRAD\_GRP\_SELx register.
- Each channel can set either normal mode or gradation mode operation in the GRAD MODE SELx register.

To enable the gradation operation, the following steps are required:

- Program all gradation control registers except the gradation start bit in GRAD\_CNTL register.
- 2. Program either LDRx = 01 (LED fully ON mode) only, or LDRx = 10 or 11 (PWM control mode) with individual brightness control PWMx register for duty cycle.
- 3. Program output current value IREFx register to non-zero, which enables LED output.
- 4. Set the gradation start bit in GRAD\_CNTL register for enabling gradation operation.

# 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# 7.2.8.1 RAMP\_RATE\_GRP0 to RAMP\_RATE\_GRP5, ramp rate control registers

Table 12. RAMP\_RATE\_GRP[0:3] - Ramp enable and rate control registers (address 40h, 44h, 48h, 4Ch, 50h, 54h) for each group bit description Legend: \* default value.

Address	Register	Bit	Access	Value	Description
40h	RAMP_RATE_GRP0	7	R/W	0*	Ramp-up disable
44h	RAMP_RATE_GRP1			1	Ramp-up enable
48h 4Ch	RAMP_RATE_GRP2 RAMP_RATE_GRP3	6	R/W	0*	Ramp-down disable
50h	RAMP_RATE_GRP4			1	Ramp-down enable
54h	RAMP_RATE_GRP5	5:0	R/W	0x00*	Ramp rate value per step is defined from 1 (00h) to 64 (3Fh) <sup>[1][2]</sup>

<sup>[1]</sup> Total number of ramp steps is defined as 'IREF\_GRP[7:0]' ÷ 'ramp\_rate[5:0]'. (Round up to next integer if it is not an integer number.)

#### 7.2.8.2 STEP\_TIME\_GRP0 to STEP\_TIME\_GRP5, step time control registers

Table 13. STEP\_TIME\_GRP[0:3] - Step time control registers (address 41h, 45h, 49h, 4Dh, 51h, 55h) for each group bit description

Address	Register	Bit	Access	Value	Description
41h	STEP_TIME_GRP0	7	read only	0*	reserved
45h 49h	STEP_TIME_GRP1	6	R/W	0*	Cycle time is set to 0.5 ms
4911 4Dh	STEP_TIME_GRP2 STEP TIME GRP3			1	Cycle time is set to 8 ms
51h 55h	STEP_TIME_GRP4 STEP_TIME_GRP5	5:0	R/W	0x00*	Multiple factor per step, the multiple factor is defined from 1 (00h) to 64 (3Fh) <sup>[1]</sup>

<sup>[1]</sup> Step time = cycle time (0.5 ms or 8 ms) × multiple factor (1 ~ 64); minimum step time is 0.5 ms and maximum step time is 512 ms.

<sup>[2]</sup> Per step current increment or decrement is calculated by the (ramp\_rate × I<sub>ref</sub>), where the I<sub>ref</sub> reference current is 125 μA (REXT = 2 kΩ).

# 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# 7.2.8.3 HOLD\_CNTL\_GRP0 to HOLD\_CNTL\_GRP5, hold ON and OFF control registers

Table 14. HOLD\_CNTL\_GRP[0:3] - Hold ON and OFF enable and time control registers (address 42h, 46h, 4Ah, 4Eh, 52h, 56h) for each group bit description Legend: \* default value.

Address	Register	Bit	Access	Value	Description
42h	HOLD_CNTL_GRP0	7	R/W	0*	Hold ON disable
46h	HOLD_CNTL_GRP1			1	Hold ON enable
4Ah 4Eh	HOLD_CNTL_GRP2 HOLD_CNTL_GRP3	6	R/W	0*	Hold OFF disable
52h	HOLD_CNTL_GRP4			1	Hold OFF enable
56h	HOLD_CNTL_GRP5	5:3	R/W	000*	Hold ON time select: <sup>[1]</sup> 000: 0 s 001: 0.25 s 010: 0.5 s 011: 0.75 s 100: 1 s 101: 2 s 110: 4 s 111: 6 s
		2:0	R/W	000*	Hold OFF time select: <sup>[1]</sup> 000: 0 s 001: 0.25 s 010: 0.5 s 011: 0.75 s 100: 1 s 101: 2 s 110: 4 s 111: 6 s

<sup>[1]</sup> Hold ON or OFF minimum time is 0 s and maximum time is 6 s.

# 7.2.8.4 IREF\_GRP0 to IREF\_GRP5, output gain control

Table 15. IREF\_GRP[0:3] - Final and hold ON output gain setting registers (address 43h, 47h, 4Bh, 4Fh, 53h, 57h) for each group bit description Legend: \* default value.

Address	Register	Bit	Access	Value	Description
43h	IREF_GRP0	7:0	R/W	00h*	Final ramp-up and hold ON output
47h	IREF_GRP1				current gain setting <sup>[1]</sup>
4Bh	IREF_GRP2				
4Fh	IREF_GRP3				
53h	IREF_GRP4				
57h	IREF_GRP5				

[1] Output current =  $I_{ref} \times IREF\_GRPx$ [7:0], where  $I_{ref}$  is reference current.  $I_{ref} = 125 \mu A$  if REXT =  $2 k\Omega$ ,

# 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# 7.2.8.5 GRAD\_MODE\_SEL0 to GRAD\_MODE\_SEL2, Gradation mode select registers

Table 16. GRAD\_MODE\_SEL[0:1] - Gradation mode select register for channel 23 to channel 0 (address 58h, 59h, 5Ah) bit description

Legend: \* default value.

Address	Register	Bit	Access	Value	Description <sup>[1][2]</sup>
58h	GRAD_MODE_SEL0	7:0	R/W	00*	Normal operation mode for channel 7 to channel 0
				FFh	Gradation operation mode for channel 7 to channel 0
59h	GRAD_MODE_SEL1	7:0	R/W	00*	Normal operation mode for channel 15 to channel 8
				FFh	Gradation operation mode for channel 15 to channel 8
5Ah	Ah GRAD_MODE_SEL2		R/W	00*	Normal operation mode for channel 23 to channel 16
				FFh	Gradation operation mode for channel 23 to channel 16

<sup>[1]</sup> Each bit represents one channel that can set either 0 for normal mode (use IREFx to set individual LED output current), or 1 for gradation mode (use IREF\_GRPx to set group LEDs output current.).

# 7.2.8.6 GRAD\_GRP\_SEL0 to GRAD\_GRP\_SEL11, Gradation group select registers

Table 17. GRAD\_GRP\_SEL[0:3] - Gradation group select register for channel 23 to channel 0 (address 5Bh, 5Ch, 5Dh, 5Eh, 5Fh, 60h, 61h, 62h, 63h, 64h, 65h, 66h) bit description

Address	Register	Bit	Access	Value	Description <sup>[1]</sup>
5Bh	GRAD_GRP_SEL0	7	R/W	0*	Reserved
		6:4	R/W	000*	Gradation group select for LED1 output
		3	R/W	0*	Reserved
		2:0	R/W	000*	Gradation group select for LED0 output
5Ch	GRAD_GRP_SEL1	7	R/W	0*	Reserved
		6:4	R/W	000*	Gradation group select for LED3 output
		3	R/W	0*	Reserved
		2:0	R/W	000*	Gradation group select for LED2 output
5Dh	GRAD_GRP_SEL2	7	R/W	0*	Reserved
		6:4	R/W	001*	Gradation group select for LED5 output
		3	R/W	0*	Reserved
		2:0	R/W	001*	Gradation group select for LED4 output
5Eh	GRAD_GRP_SEL3	7	R/W	0*	Reserved
		6:4	R/W	001*	Gradation group select for LED7 output
		3	R/W	0*	Reserved

<sup>[2]</sup> In gradation mode, it only affects the source of the IREF current level and does not affect the PWMx operation or LEDOUTx registers' function. It is possible to use the gradation feature, individual PWMx and group PWM simultaneously.

# 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

Table 17. GRAD\_GRP\_SEL[0:3] - Gradation group select register for channel 23 to channel 0 (address 5Bh, 5Ch, 5Dh, 5Eh, 5Fh, 60h, 61h, 62h, 63h, 64h, 65h, 66h) bit description...continued

Address	Register	Bit	Access	Value	Description <sup>[1]</sup>
		2:0	R/W	001*	Gradation group select for LED6 output
5Fh	GRAD_GRP_SEL4	7	R/W	0*	Reserved
		6:4	R/W	010*	Gradation group select for LED9 output
		3	R/W	0*	Reserved
		2:0	R/W	010*	Gradation group select for LED8 output
60h	GRAD_GRP_SEL5	7	R/W	0*	Reserved
		6:4	R/W	010*	Gradation group select for LED11 output
		3	R/W	0*	Reserved
		2:0	R/W	010*	Gradation group select for LED10 output
61h	GRAD_GRP_SEL6	7	R/W	0*	Reserved
		6:4	R/W	011*	Gradation group select for LED13 output
		3	R/W	0*	Reserved
		2:0	R/W	011*	Gradation group select for LED12 output
62h	GRAD_GRP_SEL7	7	R/W	0*	Reserved
		6:4	R/W	011*	Gradation group select for LED15 output
		3	R/W	0*	Reserved
		2:0	R/W	011*	Gradation group select for LED14 output
63h	GRAD_GRP_SEL8	7	R/W	0*	Reserved
		6:4	R/W	100*	Gradation group select for LED17 output
		3	R/W	0*	Reserved
		2:0	R/W	100*	Gradation group select for LED16 output
64h	GRAD_GRP_SEL9		R/W	0*	Reserved
		6:4	R/W	100*	Gradation group select for LED19 output
		3	R/W	0*	Reserved
		2:0	R/W	100*	Gradation group select for LED18 output
65h	GRAD_GRP_SEL10	7	R/W	0*	Reserved
		6:4	R/W	101*	Gradation group select for LED21 output
		3	R/W	0*	Reserved
		2:0	R/W	101*	Gradation group select for LED20 output
66h	GRAD_GRP_SEL11	7	R/W	0*	Reserved
		6:4	R/W	101*	Gradation group select for LED23 output
		3	R/W	0*	Reserved
		2:0	R/W	101*	Gradation group select for LED22 output

# 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

LED[3:0] outputs default assigned to group 0; LED[7:4] outputs default assigned to group 1; LED[11:8] outputs default assigned to group 2; LED[15:12] outputs default assigned to group 3;

LED[19:16] outputs default assigned to group 4; LED[23:20] outputs default assigned to group 5.

#### 7.2.8.7 GRAD\_CNTL, Gradation control register

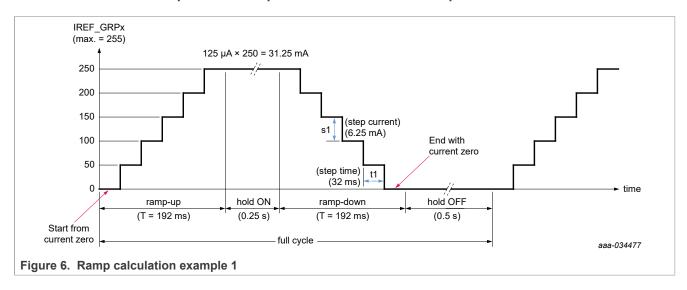
Table 18. GRAD\_CNTL[0:1] - Gradation control register for group 5 to group 0 (address 67h, 68h) bit description

Address	Register	Bit	Access	Value	Description	
67h	GRAD_CNTL0	7	R/W	0*	Gradation stop or done for group 3 <sup>[1]</sup>	
				1	Gradation start for group 3 <sup>[2]</sup>	
		6	R/W	0*	Single shot operation for group 3	
				1	Continuous operation for group 3	
		5	R/W	0*	Gradation stop or done for group 2 <sup>[1]</sup>	
				1	Gradation start for group 2 <sup>[2]</sup>	
		4	R/W	0*	Single shot operation for group 2	
				1	Continuous operation for group 2	
		3	R/W	0*	Gradation stop or done for group 1 <sup>[1]</sup>	
				1	Gradation start for group 1 <sup>[2]</sup>	
		2	R/W	0*	Single shot operation for group 1	
				1	Continuous operation for group 1	
		1	R/W	0*	Gradation stop or done for group 0 <sup>[1]</sup>	
				1	Gradation start for group 0 <sup>[2]</sup>	
		0	R/W	0*	Single shot operation for group 0	
				1	Continuous operation for group 0	
68h	GRAD_CNTL1	7	R/W	0*	Gradation stop or done for group 5 <sup>[1]</sup>	
				1	Gradation start for group 5 <sup>[2]</sup>	
		6	R/W	0*	Single shot operation for group 5	
				1	Continuous operation for group 5	
		5	R/W	0*	Gradation stop or done for group 4 <sup>[1]</sup>	
				1	Gradation start for group 4 <sup>[2]</sup>	
		4	R/W	0*	Single shot operation for group 4	
				1	Continuous operation for group 4	
		3:0	R	0*	Reserved	

When the gradation operation is forced to stop, the output current stops immediately and is frozen at the last output level. This bit will be self-cleared when single mode is completed, and writing 0 to this bit will force to stop the gradation operation when single mode is not completed or continuous mode is running.

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

#### 7.2.8.8 Ramp control — equation and calculation example

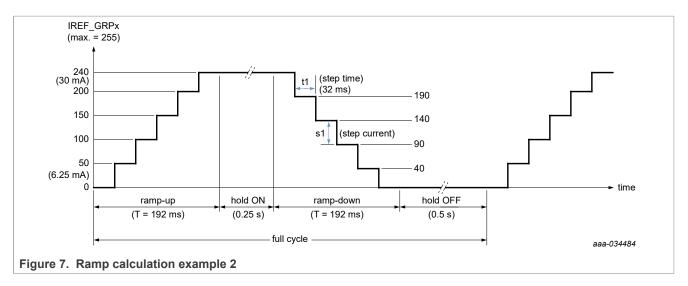


- t1 (step time) = cycle time × multiple factor, where:
  - Cycle time = 0.5 ms (fast ramp) or 8 ms (slow ramp) in STEP\_TIME\_GRPx[6]
  - Multiple factor = 6-bit, from 1 (00h) to 64 (3Fh) counts in STEP\_TIME\_GRPx[5:0]
- s1 (step current) = ramp\_rate × I<sub>ref</sub>, where:
  - ramp\_rate = 6-bit, from 1 (00h) to 64 (3Fh) counts in RAMP\_RATE\_GRPx[5:0]
  - $I_{ref}$  = reference current of 125  $\mu$ A if REXT = 2  $k\Omega$
- S (total steps) = (IREF\_GRPx / ramp\_rate), where:
  - IREF\_GRPx = output current gain setting, 8-bit, up to 255 counts
  - ramp\_rate = 6-bit, up to 64 counts in RAMP\_RATE\_GRPx[5:0]
  - If it is not an integer, then round up to next integer number.
- T (ramp time) = (S (total steps) + 1) × t1 (step time)
  - Ramp-up time starts from zero current and ends at the maximum current
  - Ramp-down time starts from the maximum current and ends at the zero current

# Calculation example 1 (Figure 6):

- · Assumption:
  - $I_{ref}$  = 125  $\mu$ A if REXT = 2  $k\Omega$
  - Output hold ON current =  $125 \mu A \times 250 = 31.25 mA$  (IREF GRPx[7:0] = FAh)
  - Cycle time = 0.5 ms (STEP\_TIME\_GRPx[6] = 0)
  - Multiple factor = 64 (STEP TIME GRPx[5:0] = 3Fh)
  - Ramp rate = 50 (RAMP\_RATE\_GRPx[5:0] = 31h)
  - Hold ON = 0.25 s (HOLD CNTL GRPx[5:3] = 001)
  - Hold OFF = 0.5 s (HOLD\_CNTL\_GRPx[2:0] = 010)
- t1 (step time) = cycle time (0.5 ms) × multiple (64) = 32 ms
- Step current = ramp\_rate × I<sub>ref</sub> = 50 × 125 μA = 6.25 mA
- S (total steps) = (IREF GRPx ÷ ramp rate) = (250 ÷ 50) = 5 steps
- T (ramp time) =  $(S + 1) \times t1 = 6 \times 32 \text{ ms} = 192 \text{ ms}$

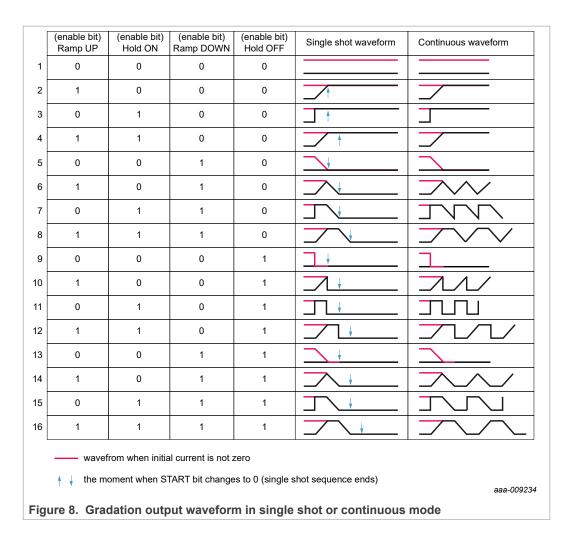
#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver



#### Calculation example 2:

- Assumption:
  - $I_{ref}$  = 125  $\mu$ A if REXT = 2  $k\Omega$
  - Output hold ON current =  $125 \mu A \times 240 = 30 \text{ mA}$  (IREF GRPx[7:0] = F0h)
  - Cycle time = 0.5 ms (STEP TIME GRPx[6] = 0)
  - Multiple factor = 64 (STEP\_TIME\_GRPx[5:0] = 3Fh)
  - Ramp rate = 50 (RAMP\_RATE\_GRPx[5:0] = 31h)
  - Hold ON = 0.25 s (HOLD\_CNTL\_GRPx[5:3] = 001)
  - Hold OFF = 0.5 s (HOLD CNTL GRPx[2:0] = 010)
- t1 (step time) = cycle time (0.5 ms) × multiple (64) = 32 ms
- Step current = ramp rate  $\times$  I<sub>ref</sub> = 50  $\times$  125  $\mu$ A = 6.25 mA (except the last one)
- S (total steps) = IREF\_GRPx ÷ ramp\_rate = 240 ÷ 50 = 4.8 steps (round up to next integer) = 5 steps
- T (ramp time) =  $(S + 1) \times t1 = 6 \times 32 \text{ ms} = 192 \text{ ms}$

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver



# 7.2.9 OFFSET — LEDn output delay offset register

Table 19. OFFSET - LEDn output delay offset register (address 69h) bit description Legend: \* default value.

Address	Register	Bit	Access	Value	Description
69h	OFFSET 7:4 read only 0000*		0000*	not used	
		3:0	R/W	1000*	LEDn output delay offset factor (0000 - 1011)

The PCA9957 can be programmed to have turn-on delay between LED outputs. This helps to reduce peak current for the  $V_{DD}$  supply and reduces EMI.

This turn-on delay also applies to  $\overline{OE}$  pin when becomes low.

The order in which the LED outputs are enabled will always be the same (channel 0 will enable first and channel 23 will enable last).

OFFSET control register bits [3:0] determine the delay used between the turn-on times as follows, and the valid number is 0000-1011. The number greater than 1011 (such as 1100-1111) will have the same turn-on delay as 1011 setting  $(1.375~\mu S)$ , and read back value will be changed to 1011:

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

```
0000 = no delay between outputs (all on, all off at the same time)
0001 = delay of 1 clock cycle (125 ns) between successive outputs
0010 = delay of 2 clock cycles (250 ns) between successive outputs
0011 = delay of 3 clock cycles (375 ns) between successive outputs
:
1011 = delay of 11 clock cycles (1.375 μs) between successive outputs
:
```

1111 = delay of 11 clock cycles (1.375  $\mu$ s) between successive outputs

**Example:** If the value in the OFFSET register is 1000, the corresponding delay =  $8 \times 125$  ns = 1  $\mu$ s delay between successive outputs.

```
channel 0 turns on at time 0 µs
channel 1 turns on at time 1 µs
channel 2 turns on at time 2 µs
channel 3 turns on at time 3 µs
channel 4 turns on at time 4 µs
channel 5 turns on at time 5 µs
channel 6 turns on at time 6 µs
channel 7 turns on at time 7 µs
channel 8 turns on at time 8 µs
channel 9 turns on at time 9 µs
channel 10 turns on at time 10 µs
channel 11 turns on at time 11 µs
channel 12 turns on at time 12 µs
channel 13 turns on at time 13 µs
channel 14 turns on at time 14 µs
channel 15 turns on at time 15 µs
channel 16 turns on at time 16 µs
channel 17 turns on at time 17 µs
channel 18 turns on at time 18 µs
channel 19 turns on at time 19 µs
channel 20 turns on at time 20 µs
channel 21 turns on at time 21 µs
channel 22 turns on at time 22 µs
channel 23 turns on at time 23 µs
```

#### 7.2.10 PWMALL — brightness control for all LEDn outputs

When programmed, the value in this register will be used for PWM duty cycle for all the LEDn outputs and will be reflected in PWM0 through PWM23 registers.

Table 20. PWMALL - brightness control for all LEDn outputs register (address 6Ah) bit description

Legend: \* default value.

Address	Register	Bit	Access	Value	Description
6Ah	PWMALL	7:0	write only	0000 0000*	duty cycle for all LEDn outputs

**Remark:** Write to any of the PWM0 to PWM23 registers will overwrite the value in corresponding PWMn register programmed by PWMALL.

PCA9957

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2021. All rights reserved

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# 7.2.11 IREFALL register: output current value for all LED outputs

The output current setting for all outputs is held in this register. When this register is written to or updated, all LED outputs will be set to a current corresponding to this register value.

Writes to IREF0 to IREF23 will overwrite the output current settings.

Table 21. IREFALL - Output gain control for all LED outputs (address 6Bh) bit description

Legend: \* default value.

Address	Register	Bit	Access	Value	Description
6Bh	IREFALL	7:0	write only	00h*	Current gain setting for all LED outputs.

#### 7.2.12 LED driver constant current outputs

In LED display applications, PCA9957 provides nearly no current variations, the absolute accuracy is less than  $\pm$  6.5 %.

#### 7.2.12.1 Adjusting output current

The PCA9957 scales up the reference current ( $I_{ref}$ ) set by the external resistor ( $R_{ext}$ ) to sink the output current ( $I_O$ ) at each output port. The maximum output current for the outputs can be set using  $R_{ext}$ . In addition, the constant value for current drive at each of the outputs is independently programmable using command registers IREF0 to IREF23. Alternatively, programming the IREFALL register allows all outputs to be set at one current value determined by the value in IREFALL register.

Equation 4 and Equation 5 can be used to calculate the minimum and maximum constant current values that can be programmed for the outputs for a chosen  $R_{\text{ext}}$ .

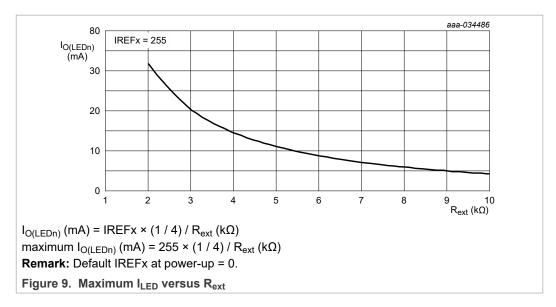
$$I_{O}\_LED\_MIN = \frac{1000mV}{R_{ext}} \times \frac{1}{4}$$
 (minimum constant current) (4)

$$I_{O}\_LED\_MAX = \left(\ 255 \times I_{O}\_LED\_MIN\ \right) = \left(\frac{1000mV}{R_{ext}} \times \frac{255}{4}\ \right) \ (5)$$

For a given IREFx setting:

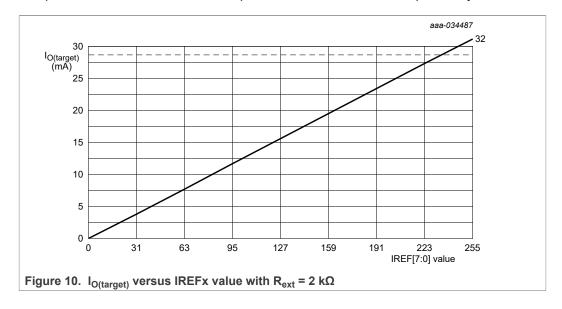
$$I_{O}$$
\_LED =  $IREFx \times \frac{1000mV}{R_{ext}} \times \frac{1}{4}$ 

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver



**Example 1:** If  $R_{ext} = 2 k\Omega$ ,  $I_{O}\_LED\_MIN = 125.0 \mu A$ ,  $I_{O}\_LED\_MAX = 31.875 mA$  (as shown in Figure 10).

So each channel can be programmed with its individual IREFx in 256 steps and in  $125 \mu A$  increments to a maximum output current of  $31.875 \mu A$  independently.



#### 7.2.13 LED error detection

The PCA9957 is capable of detecting an LED open or a short condition at its open-drain LED outputs. Users will recognize these faults by reading the status of a pair of error bits (ERRx) in error flag registers (EFLAGn) for each channel. Both LDRx value in LEDOUTx registers and IREFx value must be set to '00' for those unused LED output channels. If the output is selected to be fully on, individual dim, or individual and group dim, that channel will be tested.

The user can poll the ERROR status bit (bit 6 in MODE2 register) to check if there is a fault condition in any of the 24 channels. The EFLAGn registers can then be read to determine which channels are at fault and the type of fault in those channels.

PCA9957

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2021. All rights reserved.

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

The error status reported by the EFLAGn register is real time information, when AUTO\_SWITCHOFF\_DIS = 1, it will get self cleared once the error is fixed or write '1' to CLRERR bit (bit 4 in MODE2 register), when AUTO\_SWITCHOFF\_DIS = 0, PCA9957 will stop detection once error occurs, the EFLAGn register will keep the last error status until write '1' to CLRERR bit or get reset.

**Remark:** When LED outputs programmed with LDRx = 10 or 11 in LEDOUT[3:0] registers, checks for open and short-circuit will not occur if the PWM value in PWM0 to PWM23 registers is less than 8 or 255 (100 % duty cycle).

Table 22. EFLAG0 to EFLAG5 - Error flag registers (address 02h to 07h) bit description

Legend: \* default value.

Address	Register	Bit	Symbol	Access	Value	Description
02h	EFLAG0	7:6	ERR3	R only	00*	Error status for LED3 output
		5:4	ERR2	R only	00*	Error status for LED2 output
		3:2	ERR1	R only	00*	Error status for LED1 output
		1:0	ERR0	R only	00*	Error status for LED0 output
03h	EFLAG1	7:6	ERR7	R only	00*	Error status for LED7 output
		5:4	ERR6	R only	00*	Error status for LED6 output
		3:2	ERR5	R only	00*	Error status for LED5 output
		1:0	ERR4	R only	00*	Error status for LED4 output
04h	EFLAG2	7:6	ERR11	R only	00*	Error status for LED11 output
		5:4	ERR10	R only	00*	Error status for LED10 output
		3:2	ERR9	R only	00*	Error status for LED9 output
		1:0	ERR8	R only	00*	Error status for LED8 output
05h	EFLAG3	7:6	ERR15	R only	00*	Error status for LED15 output
		5:4	ERR14	R only	00*	Error status for LED14 output
		3:2	ERR13	R only	00*	Error status for LED13 output
		1:0	ERR12	R only	00*	Error status for LED12 output
06h	EFLAG4	7:6	ERR19	R only	00*	Error status for LED19 output
		5:4	ERR18	R only	00*	Error status for LED18 output
		3:2	ERR17	R only	00*	Error status for LED17 output
		1:0	ERR16	R only	00*	Error status for LED16 output
07h	EFLAG5	7:6	ERR23	R only	00*	Error status for LED23 output
		5:4	ERR22	R only	00*	Error status for LED22 output
		3:2	ERR21	R only	00*	Error status for LED21 output
		1:0	ERR20	R only	00*	Error status for LED20 output

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

Table 23. ERRx bit description

LED error detection	ERRx		Description
status	Bit 1	Bit 0	
No error	0	0	In normal operation and no error
Short-circuit	0	1	Detected LED short-circuit condition
Open-circuit	1	0	Detected LED open-circuit condition
DNE (Do Not Exist)	1	1	This condition does not exist

#### 7.2.13.1 Open-circuit detection principle

The PCA9957 LED open-circuit detection compares the effective current level  $I_O$  with the open load detection threshold current  $I_{th(det)}$ . If  $I_O$  is below the threshold  $I_{th(det)}$ , the PCA9957 detects an open load condition. This error status can be read out as an error flag through the EFLAGn registers. For open-circuit error detection of an output channel, that channel must be ON.

Table 24. Open-circuit detection

State of output port	Condition of output current	Condition of output Error status code current	
OFF	$I_O = 0 \text{ mA}$	0	detection not possible
ON	$I_{O} < I_{th(det)}^{[1]}$	1	open-circuit
	$I_O \ge I_{th(det)}^{[1]}$	this channel open error status bit is 0	normal

<sup>[1]</sup>  $I_{th(det)} = 0.5 \times I_{O(target)}$  (typical). This threshold may be different for each I/O and only depends on IREFx and  $R_{ext}$ 

#### 7.2.13.2 Short-circuit detection principle

The LED short-circuit detection compares the effective output voltage level ( $V_O$ ) with the shorted-load detection threshold voltages  $V_{th(trig)}$ . If  $V_O$  is above the  $V_{th(trig)}$  threshold, the PCA9957 detects a shorted-load condition. If  $V_O$  is below the  $V_{th(trig)}$  threshold, no error is detected and error bit is set to '0'. This error status can be read out as an error flag through the EFLAGn registers. For short-circuit error detection of an output channel, that channel must be ON.

Table 25. Short-circuit detection

Table 23. Officit-circuit detection								
State of output port	Condition of output voltage	Error status code	Description					
OFF	-	0	detection not possible					
ON	$V_O \ge V_{th(trig)}^{[1]}$	1	short-circuit					
	$V_{O} < V_{th(trig)}^{[1]}$	this channel short error status bit is 0	normal					

<sup>[1]</sup>  $V_{th}\cong 1.96~V.$ 

**Remark:** The error status distinguishes between an LED short condition and an LED open condition. Upon detecting an LED short or open, the corresponding LED outputs should be turned OFF to prevent heat dissipation for a short in the chip. Although an open event will not be harmful, the outputs should be turned OFF for both occasions to repair the LED string.

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# 7.2.14 Overtemperature protection

If the PCA9957 chip temperature exceeds its limit ( $T_{th(otp)}$  (rising) maximum, see  $\underline{\text{Table 28}}$ ), all output channels will be disabled until the temperature drops below its limit minus a small hysteresis ( $T_{th(otp)}$  (hysteresis) maximum, see  $\underline{\text{Table 28}}$ ). When an overtemperature situation is encountered, the OVERTEMP flag (bit 7) is set in the MODE2 register. Once the die temperature reduces below the  $T_{th(otp)}$  rising -  $T_{th(otp)}$  hysteresis, the chip will return to the same condition it was prior to the overtemperature event and the OVERTEMP flag will be cleared.

# 7.3 Active LOW output enable input

The active LOW output enable ( $\overline{\text{OE}}$ ) pin on PCA9957 allows to enable or disable all the LED outputs at the same time.

- When a LOW level is applied to  $\overline{\text{OE}}$  pin, all the LED outputs are enabled, LEDn output delay applies to this sequence.
- When a HIGH level is applied to  $\overline{\text{OE}}$  pin, all the LED outputs are high-impedance.

The  $\overline{\text{OE}}$  pin can be used as a synchronization signal to switch on/off several PCA9957 devices at the same time when LED drive output state is set fully ON (LDRx = 01 in LEDOUTx register) in these devices. This requires an external clock reference that provides blinking period and the duty cycle.

The  $\overline{\text{OE}}$  pin can also be used as an external dimming control signal. The frequency of the external clock must be high enough not to be seen by the human eye, and the duty cycle value determines the brightness of the LEDs.

LEDn output delay controlled by register OFFSET also applies  $\overline{OE}$  control.

**Remark:** Do not use  $\overline{OE}$  as an external blinking control signal when internal global blinking is selected (DMBLNK = 1, MODE2 register) since it will result in an undefined blinking pattern. Do not use  $\overline{OE}$  as an external dimming control signal when internal global dimming is selected (DMBLNK = 0, MODE2 register) since it will result in an undefined dimming pattern.

#### 7.4 Power-on reset

When power is applied to  $V_{DD}$ , an internal power-on reset holds the PCA9957 in a reset condition until  $V_{DD}$  has reached  $V_{POR}$ . At this point, the reset condition is released and the PCA9957 registers and serial bus state machine are initialized to their default states (all zeroes) causing all the channels to be deselected. Thereafter,  $V_{DD}$  must be pulled lower than 1 V and stay LOW for longer than 20  $\mu$ s. The device will reset itself, and allow 2 ms for the device to fully wake up.

# 7.5 Hardware reset recovery

When a reset of PCA9957 is activated using an active LOW input on the RESET pin, a reset pulse width of 2.5 µs minimum is required. The maximum wait time after RESET pin is released is 1.5 ms.

#### 7.6 Individual brightness control with group dimming/blinking

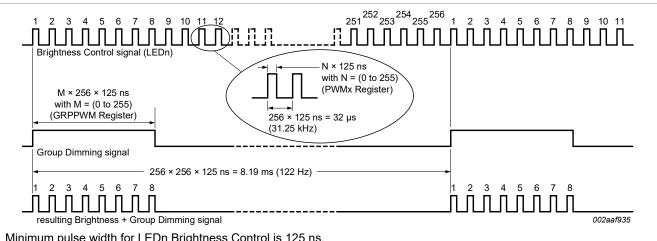
A 31.25 kHz fixed frequency signal with programmable duty cycle (8 bits, 256 steps) is used to control individually the brightness for each LED.

PCA9957

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

On top of this signal, one of the following signals can be superimposed (this signal can be applied to the 24 LED outputs LED0 to LED23).

- A lower 122 Hz fixed frequency signal with programmable duty cycle (8 bits, 256 steps) is used to provide a global brightness control.
- A programmable frequency signal from 15 Hz to every 16.8 seconds (8 bits, 256 steps) with programmable duty cycle (8 bits, 256 steps) is used to provide a global blinking control.



Minimum pulse width for LEDn Brightness Control is 125 ns.

Minimum pulse width for Group Dimming is 32 µs.

When M = 1 (GRPPWM register value), the resulting LEDn Brightness Control + Group Dimming signal will have 1 pulse of the LED Brightness Control signal (pulse width = N × 125 ns, with 'N' defined in PWMx register).

This resulting Brightness + Group Dimming signal above shows a resulting Control signal with M = 8.

Figure 11. Brightness + Group Dimming signals

# Characteristics of the 4-wire SPI serial-bus interface

The PCA9957 communicates through a daisy-chain SPI-compatible 4-wire serial interface. The interface has three inputs and one output: serial clock (SCLK), active LOW chip select  $(\overline{CS})$ , serial data in (SDI) and serial data output (SDO).  $\overline{CS}$  must be LOW to clock data into the device, and SDI must be stable when sampled on the rising edge of SCLK. The PCA9957 ignores all activity on SCLK and SDI except when  $\overline{CS}$  is LOW.

#### 8.1 SPI-compatible 4-wire serial interface signals

#### CS

The active LOW chip select line is used to activate and access the SPI slaves. As long as CS is HIGH, all slaves will not accept the clock signal or data, and output SDO is driven LOW, therefore SPI parallel connection is not supported. Whenever this pin is in a logic LOW state, data can be transferred between the master (controller) and all slaves (targets).

#### **SCLK**

Serial clock is provided by SPI master and determines the speed of the data transfer. All receiving and sending data are done synchronously (clocks the internal SPI shift register and the output driver) to this clock.

All information provided in this document is subject to legal disclaimers

© NXP B.V. 2021. All rights reserved

24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

#### SDI

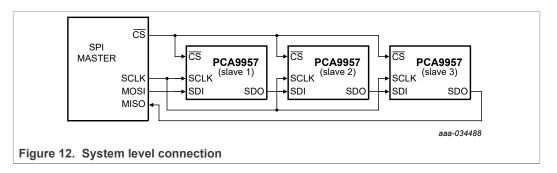
Serial Data In is read on the rising edge of SCLK into the internal 16-bit shift registers. On the rising edge of  $\overline{CS}$ , the input data is latched into the internal registers of the device. The device ignores all activity on SDI when  $\overline{CS}$  is deasserted.

#### **SDO**

Serial Data Out is the pin on which the internal 16-bit shift registers data is shifted out serially. SDO is driven LOW until the  $\overline{\text{CS}}$  pin goes to a logic LOW state. New data appears at the SDO pin following the falling edge of SCLK.

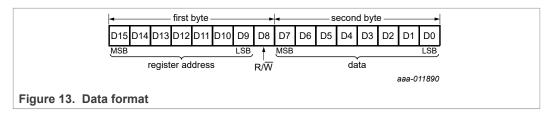
All slave devices can be daisy-chained by connecting the SDO of one device to the SDI of the next device, and driving SCLK and  $\overline{CS}$  lines in parallel. Figure 12 depicts how the slaves are connected to the master. All slave devices are accessed at the same time with  $\overline{CS}$ . An access requires (16 × n) clock cycles, where 'n' is the number of slave devices. As long as  $\overline{CS}$  is LOW, the SPI registers are working as simple shift registers and shifting through the SDI data without interpreting the different control and data bits. When  $\overline{CS}$  goes back to HIGH, the bits in the SPI registers are interpreted and the SPI logic is activated.

Only the first slave in the chain receives the control and data bits directly from the SPI Master. Every other slave in the network receives its SDI data from the SDO output of the preceding slave in the chain, and the SDO of the last slave is then connected to the data input (MISO) of SPI Master. Each slave has 16-bit shift registers shifted in from SDI and shifted out to SDO, along with the SCLK clock. The whole chain acts as a 48-bit (n × 16-bit, where 'n' is number of slaves) big shift register.



#### 8.2 Data format

As shown in Figure 13, the data transfers are 16-bit  $\times$  n bits wide (where 'n' is the number of slaves) with MSB transferred first. The first 7 bits, D[15:9], form the address of the register to be accessed, the eighth bit (D8) indicates the types of access, either read (= 1) or write (= 0), and the last 8 bits, D[7:0], consist of data. Register read and write sequences (described in the following sections) always begin from the bus idle condition. The bus idle condition refers to  $\overline{CS}$  being HIGH and SCLK being in a LOW state.



PCA9957

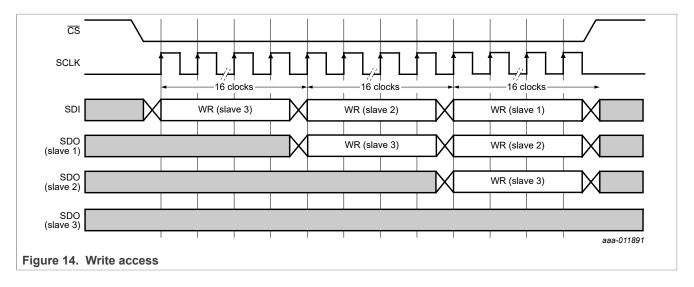
#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# 8.3 Write access sequence

The registers are written using the following write sequence (from a bus idle condition) when the system has three slaves daisy-chained together:

- 1. All the slave devices in chain will be involved in a write or read operation. Every slave device in the chain is a portion of one big shift register.
- 2. Drive CS LOW. This enables the internal 16-bit shift register.
- 3. Shift 16 × n bits of data (where 'n' is the number of slaves) into the first slave device in a MSB-first fashion. Data is shifted on the rising edge of SCLK and must be stable during the rising edge of SCLK.
- 4. The 8th bit of the data for every 16 bits (each device) must be a '0', indicating it is a write transfer.
- 5. After the last bit of data is transferred, drive SCLK LOW and deassert CS (drive it HIGH).
- 6. When  $\overline{\text{CS}}$  goes from LOW to HIGH, the data in the shift register is latched into the device registers.

If fewer than 16 bits of data are transferred before deasserting  $\overline{CS}$ , then the data is ignored and the register will not be updated. The write transfer format is shown in Figure 14.



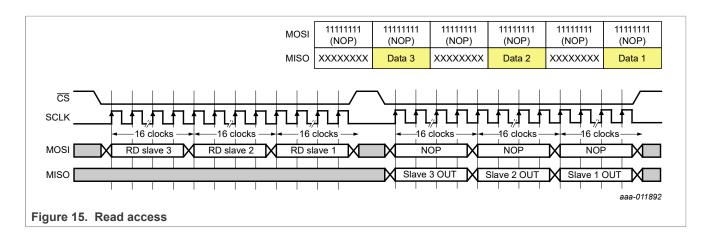
#### 8.4 Read access sequence

The registers are read using the following read sequence (from a bus idle condition) when the system has three slaves daisy-chained as shown in Figure 15.

- 1. The master sends the first three 2-byte read instructions with 48 clocks, where the first byte is a 7-bit register address, an eighth bit set to one, followed by dummy data byte (all ones).
- 2. The Read instruction is decoded when  $\overline{CS}$  is deasserted (from LOW to HIGH).
- 3. The read data is shifted out on SDO when  $\overline{CS}$  is asserted again (from HIGH to LOW).
- 4. The master sends the second three 2-byte 'No Operation' (NOP) operations (all ones) with 48 clocks and reads the requested data on MISO in sequence where the first byte is dummy data (don't care), followed by the read data byte.
- 5. A read cycle consists of asserting and deasserting of  $\overline{\text{CS}}$  twice.

PCA9957

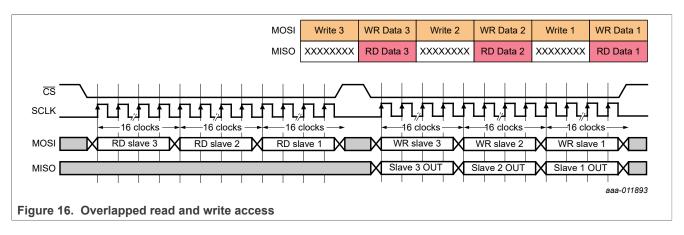
#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver



# 8.5 Overlapped read and write access sequence

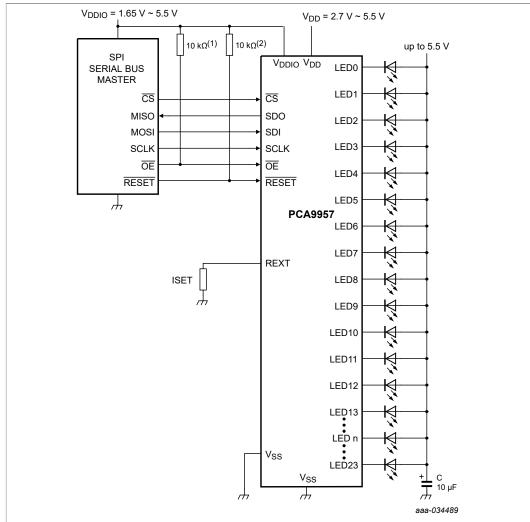
The registers are read and write overlapped using the following sequence (from a bus idle condition) when the system has three slaves daisy-chained as shown in Figure 16.

- 1. The second phase of the read cycle can be used to send in write data or the next read instruction. This increases the bus utility and hence efficiency.
- 2. The master sends the first three 2-byte read instructions with 48 clocks, where the first byte is a 7-bit register address, the eighth bit is set to one, followed by dummy data byte (all ones).
- 3. The read instruction is decoded when  $\overline{\text{CS}}$  is deasserted (from LOW to HIGH).
- 4. Start to shift read data out on SDO when  $\overline{\text{CS}}$  is asserted again (from HIGH to LOW) and start to send in the next read or write instruction on the SDI line.



#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# 9 Application design-in information



- 1.  $\overline{\text{OE}}$  requires pull-up resistor if control signal from the master is open-drain
- 2.  $\overline{\text{RESET}}$  requires a pull-up resistor of <100  $k\Omega$  if not used or connected to open-drain output

Figure 17. Typical application

#### 9.1 Thermal considerations

Since the PCA9957 device integrates 24 linear current sources, thermal considerations should be taken into account to prevent overheating, which can cause the device to go into thermal shutdown.

Perhaps the major contributor for device's overheating is the LED forward voltage mismatch. This is because it can cause significant voltage differences between the LED of the same type (for example, 2 V to 3 V), which ultimately translates into higher power dissipation in the device. The voltage drop across the LED channels of the device is given by the difference between the supply voltage and the LED forward voltage of each LED. Reducing this to a minimum (for example, 0.4 V) helps to keep the power dissipation down. Therefore LEDs binning is recommended to minimize LED voltage forward variation and reduce power dissipation in the device.

PCA9957

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

In order to ensure that the device will not go into thermal shutdown when operating under certain application conditions, its junction temperature  $(T_j)$  should be calculated to ensure that is below the overtemperature threshold limit (130 °C). The  $T_j$  of the device depends on the ambient temperature  $(T_{amb})$ , device's total power dissipation  $(P_{tot})$ , and thermal resistance.

The device junction temperature can be calculated by using the following equation:

$$T_i = T_{amb} + R_{th(i-a)} \times P_{tot}$$
(6)

#### where:

T<sub>i</sub> = junction temperature

T<sub>amb</sub> = ambient temperature

R<sub>th(j-a)</sub> = junction to ambient thermal resistance

 $P_{tot}$  = (device) total power dissipation

An example of this calculation is show below:

## **Conditions:**

 $T_{amb} = 50 \, ^{\circ}C$ 

R<sub>th(j-a)</sub> = 39 °C/W (per JEDEC 51 standard for multilayer PCB)

I<sub>LED</sub> = 30 mA / channel

 $I_{DD(max)} = 20 \text{ mA}$ 

 $V_{DD} = 3.3 \text{ V}$ 

LEDs per channel = 1 LEDs / channel

LED  $V_{F(typ)} = 3 V per LED$ 

LED V<sub>F</sub> mismatch = 0.2 V per LED

 $V_{reg(drv)}$  = 0.4 V (This will be present only in the LED string with the highest LED forward voltage.)

 $V_{sup}$  = LED  $V_{F(typ)}$  + LED  $V_{F}$  mismatch +  $V_{reg(drv)}$  = 3 V + 0.2 V + 0.4 V = 3.6 V

#### P<sub>tot</sub> calculation:

P<sub>tot</sub> = IC power + LED drivers power;

 $IC_{DD} \times V_{DD}$ 

 $IC_power = (0.02 \text{ A} \times 3.3 \text{ V}) = 0.066 \text{ W}$ 

LED drivers\_power = [(24 - 1) × ( $I_{LED}$ ) × (LED  $V_F$  mismatch +  $V_{reg(drv)}$ )] + ( $I_{LED}$  ×  $V_{reg(drv)}$ )

LED drivers\_power =  $[23 \times 0.03 \text{ A} \times (0.2 \text{ V} + 0.4 \text{ V})] + (0.03 \text{ A} \times 0.4 \text{ V})] = 0.426 \text{ W}$  $P_{\text{tot}} = 0.66 \text{ W} + 0.426 \text{ W} = 0.492 \text{ W}$ 

## T<sub>j</sub> calculation:

$$T_j = T_{amb} + R_{th(j-a)} \times P_{tot}$$
  
 $T_i = 50 \,^{\circ}\text{C} + (30 \,^{\circ}\text{C/W} \times 0.492 \,\text{W}) = 64.76 \,^{\circ}\text{C}$ 

This confirms that the junction temperature is below the minimum overtemperature threshold of 130 °C, which ensures the device will not go into thermal shutdown under these conditions.

It is important to mention that the value of the thermal resistance junction-to-ambient  $(R_{th(j-a)})$  strongly depends in the PCB design. Therefore, the thermal pad of the device should be attached to a big enough PCB copper area to ensure proper thermal dissipation (similar to JEDEC 51 standard). Several thermal vias in the PCB thermal pad

24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

should be used as well to increase the effectiveness of the heat dissipation (for example, 15 thermal vias). The thermal vias should be distributed evenly in the PCB thermal pad.

Finally, it is important to point out that this calculation should be taken as a reference only and therefore evaluations should still be performed under the application environment and conditions to confirm proper system operation.

# 10 Limiting values

Table 26. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DD}$	supply voltage		-0.5	+6.0	V
$V_{DDIO}$	supply voltage of interface		-0.5	+6.0	V
V <sub>I/O</sub>	voltage on an input/output pin		V <sub>SS</sub> - 0.5	5.5	V
$V_{drv(LED)}$	LED driver voltage		V <sub>SS</sub> - 0.5	+6.0	V
I <sub>O(LEDn)</sub>	output current on pin LEDn		-	40	mA
I <sub>SS</sub>	ground supply current		-	1.0	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	-	3.3	W
		T <sub>amb</sub> = 85 °C	-	1.3	W
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>amb</sub>	ambient temperature	operating for non AEC-Q100	-40	+85	°C
Tj	junction temperature		-40	+125	°C

## 11 Thermal characteristics

Table 27. Thermal characteristics

Symbol	Parameter	Conditions		Тур	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	HVQFN40	[1]	35.6	°C/W
R <sub>th(j-case top)</sub>	thermal resistance between the junction and the case top	HVQFN40		17.9	°C/W
R <sub>th(j-case bottom)</sub>	thermal resistance between the junction and the case bottom	HVQFN40		8.5	°C/W
R <sub>th(j-board)</sub>	thermal resistance between the junction and the board	HVQFN40	[1]	27.2	°C/W

<sup>[1]</sup> Per JEDEC 51 standard for multilayer PCB and Wind Speed (m/s) = 0.

### 12 Static characteristics

Table 28. Static characteristics

 $V_{DD}$  = 2.7 V to 5.5 V;  $V_{SS}$  = 0 V;  $T_{amb}$  = -40 °C to +85 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ <sup>[1]</sup>	Max	Unit
Supply						

PCA9957

Product data sheet

## 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

Table 28. Static characteristics...continued

 $V_{DD}$  = 2.7 V to 5.5 V;  $V_{SS}$  = 0 V;  $T_{amb}$  = -40 °C to +85 °C; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ <sup>[1]</sup>	Max	Unit
$V_{DD}$	supply voltage			2.7	-	5.5	V
$V_{DDIO}$	supply voltage of SPI interface			1.65	-	5.5	V
I <sub>DD</sub>	supply current	on pin V <sub>DD</sub> ; operating mode; f <sub>SCLK</sub> = 10 MHz					
		$R_{ext}$ = 2 k $\Omega$ ; LED[23:0] = off; IREFx = 00h		-	-	6.2	mA
		$R_{ext}$ = 2 k $\Omega$ ; LED[23:0] = on; IREFx = FFh		-	-	6.7	mA
I <sub>DDIO</sub>	supply current	on pin V <sub>DDIO</sub> ; operating mode; f <sub>SCLK</sub> = 10 MHz; keep writing mode register (01h) with 00h		-	-	650	μA
I <sub>stb</sub>	standby current	on pin $V_{DD}$ ; no load; $f_{SCLK} = 0$ Hz; MODE1[4] = 1; $V_{I} = V_{DD}$					
		V <sub>DD</sub> = 3.3 V		-	170	600	μA
		V <sub>DD</sub> = 5.5 V		-	170	700	μΑ
V <sub>POR</sub>	power-on reset voltage	no load; V <sub>I</sub> = V <sub>DD</sub> or V <sub>SS</sub>		-	2	-	V
$V_{PDR}$	power-down reset voltage	no load; $V_I = V_{DD}$ or $V_{SS}$	[2] [3]	-	1	-	V
Inputs CS,	SDI, SCLK; output SDO		1				
V <sub>IL</sub>	LOW-level input voltage			-0.5	-	+0.3V <sub>DDIO</sub>	V
V <sub>IH</sub>	HIGH-level input voltage			0.7V <sub>DDIO</sub>	-	5.5	V
V <sub>OH</sub>	HIGH-level output voltage	I <sub>OH</sub> = -3 mA at SDO		0.8V <sub>DDIO</sub>	-	-	V
V <sub>OL</sub>	LOW-level output voltage	I <sub>OL</sub> = 3 mA at SDO		-	-	0.2V <sub>DDIO</sub>	V
IL	leakage current	V <sub>I</sub> = V <sub>DDIO</sub> or V <sub>SS</sub>		-1	-	+1	μA
C <sub>i</sub>	input capacitance	$V_I = V_{SS}$		-	6	10	pF
Current co	ntrolled outputs (LED[23:0])			1			
I <sub>O(LEDn)</sub>	output current on pin LEDn	$V_O$ = 0.4 V; IREFx = 80h; $R_{ext}$ = 2 $k\Omega$	[3]	15	16	17	mA
		$V_O$ = 0.4 V; IREFx = FFh; $R_{ext}$ = 2 $k\Omega$	[3]	30	32	34	mA
ΔI <sub>O_Absolute</sub>	absolute output current variation	$V_O$ = 0.4 V; all channels on; IREFx >= 20h R <sub>ext</sub> = 2 k $\Omega$ ; refer to ideal value; guaranteed by design				±6.5	%
		$V_O$ = 0.4 V; all channels on; IREFx < 20h; R <sub>ext</sub> = 2 k $\Omega$ ; refer to ideal value; guaranteed by design				±8	%
$\Delta I_{O\_mis\_p2p}$	part to part output current mismatch	all channels on; IREFx = FFh. $R_{\text{ext}}$ = 2 k $\Omega$ ; $V_{\text{O}}$ = 0.4 V; average value of 24 output current of each device, comparing to ideal value	[4]	-	-	±6	%

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

Table 28. Static characteristics...continued

 $V_{DD}$  = 2.7 V to 5.5 V;  $V_{SS}$  = 0 V;  $T_{amb}$  = -40 °C to +85 °C; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ <sup>[1]</sup>	Max	Unit
ΔI <sub>O_mis_c2c</sub>	channel to channel output current mismatch	all channels on; IREFx = FFh. $R_{ext}$ = 2 k $\Omega$ ; $V_O$ = 0.4 V; each channel current comparing to average current of 24 channels	[5]	-	-	±4	%
V <sub>reg(drv)</sub>	driver regulation voltage	minimum regulation voltage; IREFx = FFh; $R_{ext}$ = 2 k $\Omega$		0.4		5.5	V
I <sub>L(off)</sub>	off-state leakage current	V <sub>O</sub> = 5 V		-	-	1	μA
$V_{trip}$	trip voltage	short LED protection; Error flag trips during verification test if $V_O \ge V_{trip}$ ; $R_{ext} = 2 \text{ k}\Omega$		1.85	1.96	-	V
<b>OE</b> input, ℝ	ESET input					1	,
V <sub>IL</sub>	LOW-level input voltage			-0.5	-	+0.3V <sub>DDIO</sub>	V
V <sub>IH</sub>	HIGH-level input voltage			0.7V <sub>DDIO</sub>	-	5.5	V
I <sub>LI</sub>	input leakage current			-1	-	+1	μA
C <sub>i</sub>	input capacitance		[3]	-	3.7	5	pF
Overtempe	erature protection				•		-
T <sub>th(otp)</sub>	overtemperature protection	rising	[3]	130	-	150	°C
	threshold temperature	hysteresis	[3]	15	-	30	°C

- [1]
- Typical limits at  $V_{DD}$  = 3.3 V,  $T_{amb}$  = 25 °C.  $V_{DD}$  must be lowered to 1 V in order to reset part. [2]
- Value not tested in production, but guaranteed by design and characterization.
- Part-to-part mismatch is calculated:

where 'ideal output current' = 31.875 mA ( $R_{ext}$  = 2 k $\Omega$ , IREFx = FFh). Channel-to-channel mismatch is calculated:

$$\Delta\% = \left(\frac{l_{O(LEDn)}(\text{where n} = 0 \text{ to } 23)}{\left(\frac{l_{O(LED0)}+l_{O(LED1)}+...+l_{O(LED22)}+l_{O(LED23)}}{24}\right)} - 1\right) \times 100$$

# 13 Dynamic characteristics

Table 29. Dynamic characteristics<sup>[1]</sup>

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f <sub>SCLK</sub>	SCLK clock frequency		0	-	10	MHz
t <sub>LOW</sub>	LOW period of the SCLK clock		50	-	-	ns
t <sub>HIGH</sub>	HIGH period of the SCLK clock		50	-	-	ns
t <sub>DS</sub>	data set-up time		10	-	-	ns
t <sub>DH</sub>	data hold time		20	-	-	ns
t <sub>CSS</sub>	chip select asserted to SCLK rise set-up time		10	-	-	ns
t <sub>CSH</sub>	SCLK fall to chip select deasserted hold time		0	-	-	ns
t <sub>cs_HI</sub>	minimum chip select deasserted HIGH time		40	-	-	ns

All information provided in this document is subject to legal disclaimers.

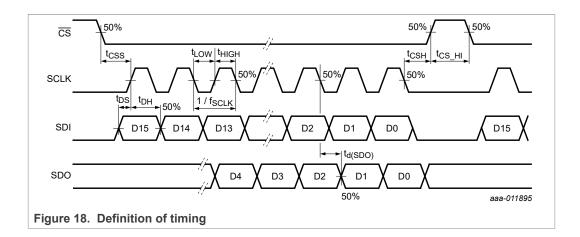
© NXP B.V. 2021. All rights reserved.

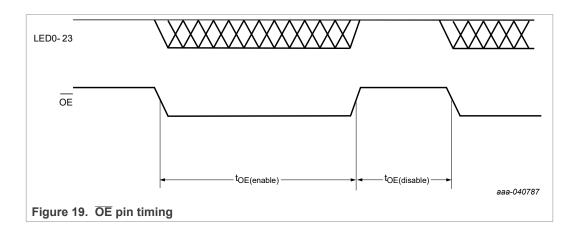
#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

Table 29. Dynamic characteristics<sup>[1]</sup>...continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t <sub>d(SDO)</sub>	SDO delay time	C <sub>L</sub> = 50 pF	-	-	40	ns
t <sub>d(LED0)</sub>	The latency time between $\overline{\text{OE}}$ pin assertion to LED channel 0 output on		-	-	1 <sup>[2]</sup>	μs
t <sub>OE(disable)</sub>	OE pin disable (HIGH) period time		250	-	-	ns
t <sub>OE(enable)</sub>	OE pin enable (LOW) period time		250	-	-	ns

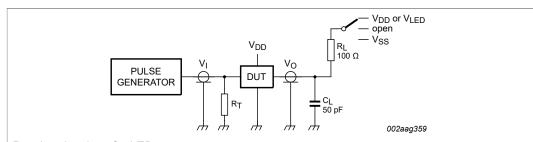
- All parameters tested at  $V_{DD}$  = 3 V to 5.5 V;  $V_{SS}$  = 0 V;  $T_{amb}$  = +25 °C. Specifications over temperature are guaranteed by design. Guaranteed by design. [1] [2]





#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# 14 Test information



 $R_L$  = Load resistor for LEDn.

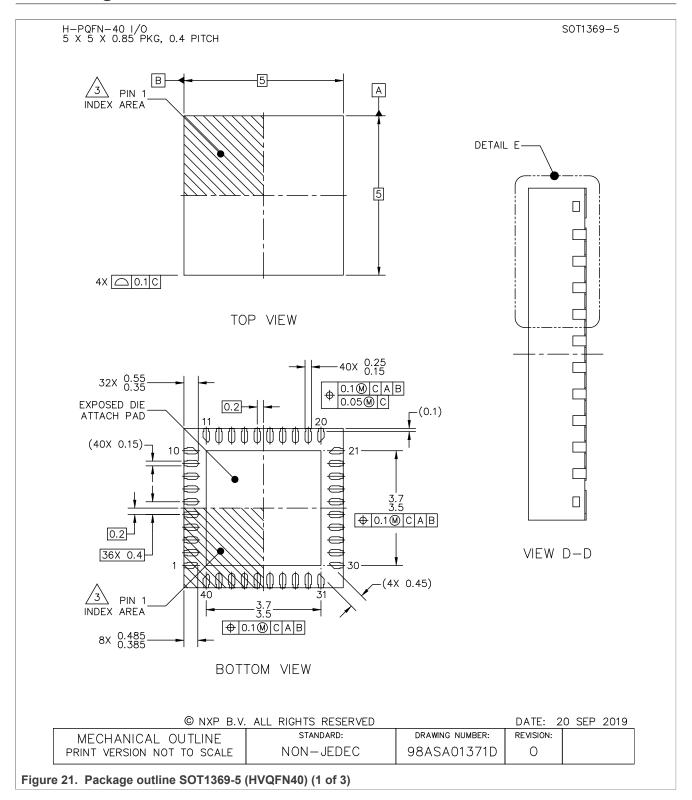
 $C_L$  = Load capacitance includes jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to the output impedance  $Z_o$  of the pulse generators.

Figure 20. Test circuitry for switching times

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# 15 Package outline



#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

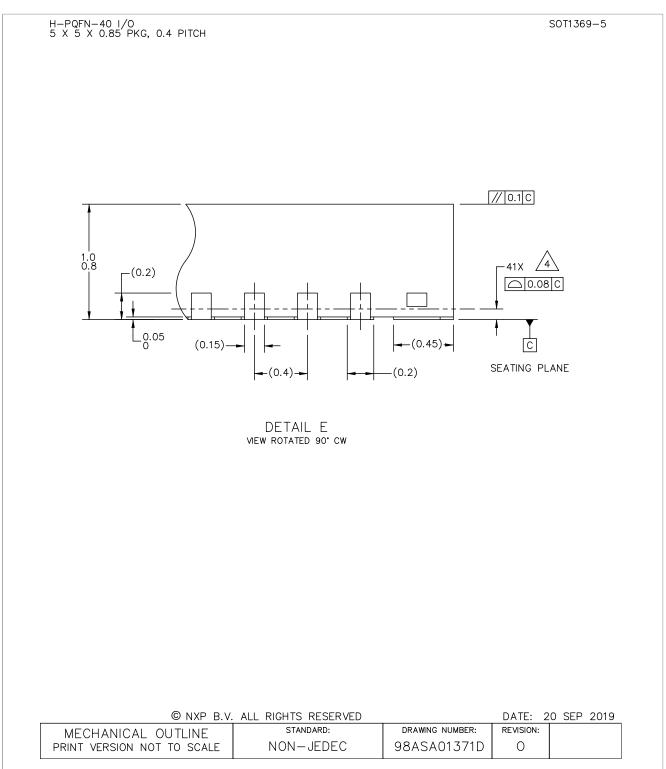


Figure 22. Package outline SOT1369-5 (HVQFN40) (2 of 3)

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

H-PQFN-40 I/O 5 X 5 X 0.85 PKG, 0.4 PITCH SOT1369-5

#### NOTES:

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.

3. PIN 1 FEATURE SHAPE, SIZE AND LOCATION MAY VARY.

4. COPLANARITY APPLIES TO LEADS AND DIE ATTACH FLAG.

5. MIN. METAL GAP SHOULD BE 0.15 MM.

© NXP B.V. ALL RIGHTS RESERVED

DATE: 20 SEP 2019

MECHANICAL OUTLINE	STANDARD:	DRAWING NUMBER:	REVISION:	
PRINT VERSION NOT TO SCALE	NON-JEDEC	98ASA01371D	0	

Figure 23. Package outline SOT1369-5 (HVQFN40) (3 of 3)

24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# 16 Handling information

All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling ensure that the appropriate precautions are taken as described in *JESD625-A* or equivalent standards.

# 17 Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

### 17.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

#### 17.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- · Board specifications, including the board finish, solder masks and vias
- · Package footprints, including solder thieves and orientation
- · The moisture sensitivity level of the packages
- Package placement
- · Inspection and repair
- · Lead-free soldering versus SnPb soldering

## 17.3 Wave soldering

Key characteristics in wave soldering are:

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- · Solder bath specifications, including temperature and impurities

### 17.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 24</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board
  is heated to the peak temperature) and cooling down. It is imperative that the peak
  temperature is high enough for the solder to make reliable solder joints (a solder
  paste characteristic). In addition, the peak temperature must be low enough that the
  packages and/or boards are not damaged. The peak temperature of the package
  depends on package thickness and volume and is classified in accordance with
  Table 30 and Table 31

Table 30. SnPb eutectic process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature	(°C)
	Volume (mm³)	
	< 350	≥ 350
< 2.5	235	220
≥ 2.5	220	220

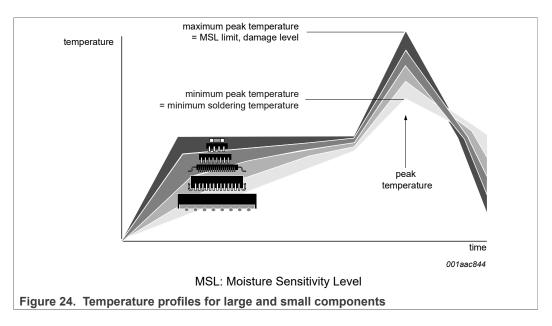
Table 31. Lead-free process (from J-STD-020D)

Package thickness (mm)	Package reflow	Package reflow temperature (°C)				
	Volume (mm³)	Volume (mm³)				
	< 350	350 to 2000	> 2000			
< 1.6	260	260	260			
1.6 to 2.5	260	250	245			
> 2.5	250	245	245			

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see <u>Figure 24</u>.

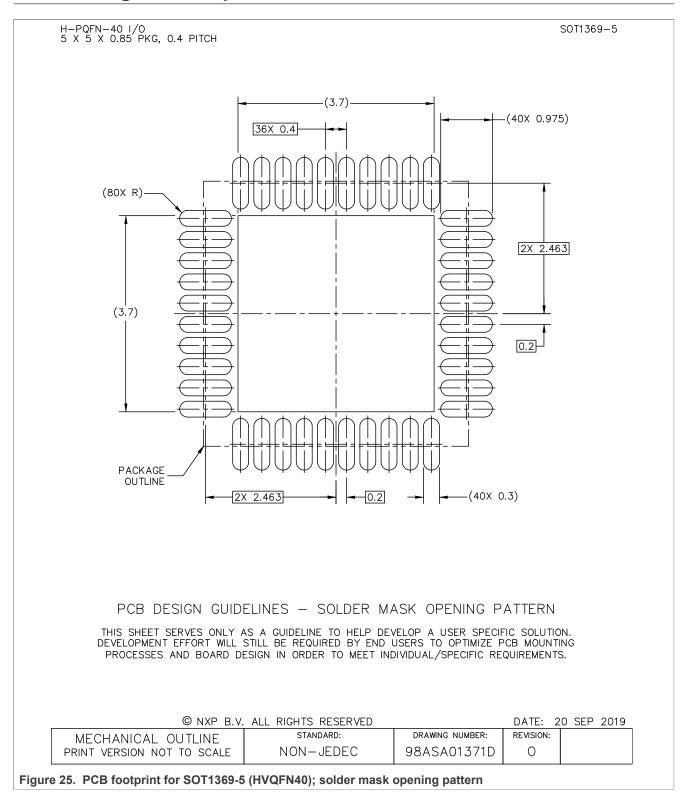
#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver



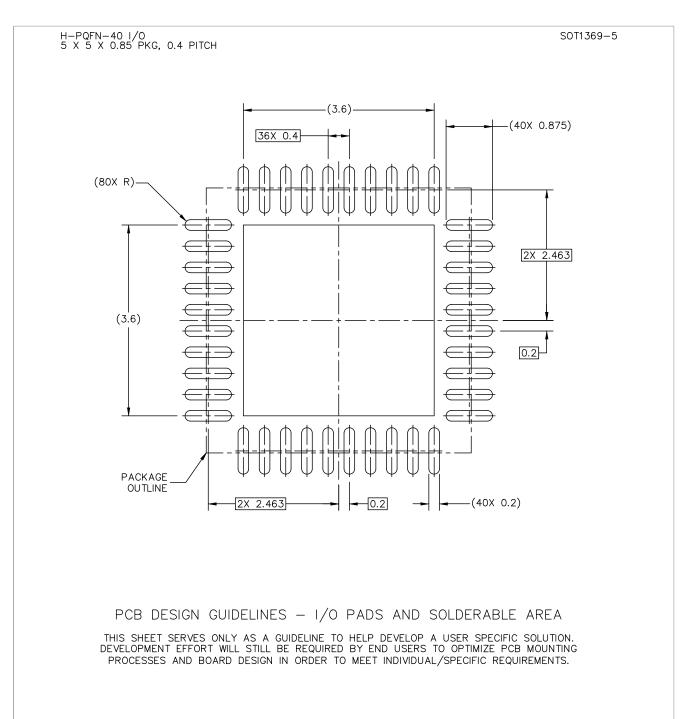
For further information on temperature profiles, refer to Application Note *AN10365* "Surface mount reflow soldering description".

## 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# 18 Soldering: PCB footprints



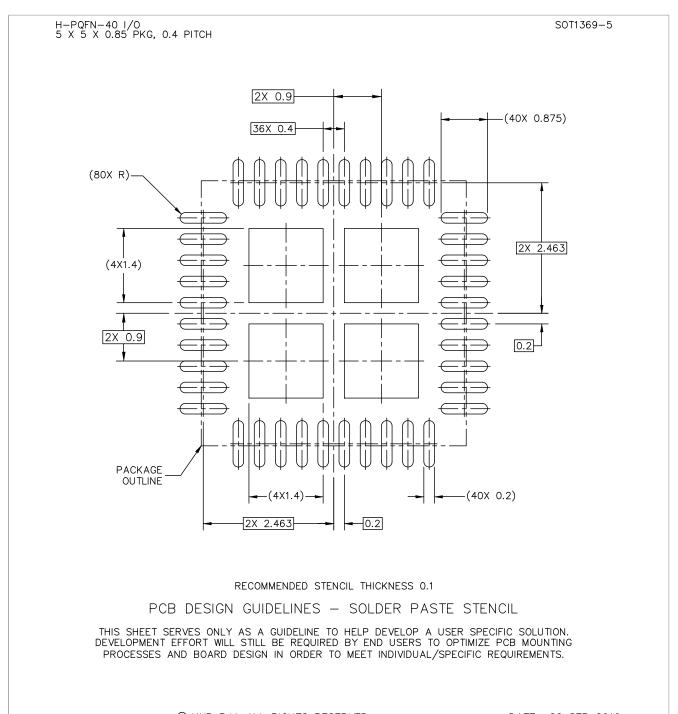
#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver



© NXP B.V.	ALL RIGHTS RESERVED		DATE: 2	0 SEP 2019
MECHANICAL OUTLINE	STANDARD:	DRAWING NUMBER:	REVISION:	
PRINT VERSION NOT TO SCALE	NON-JEDEC	98ASA01371D	0	

Figure 26. PCB footprint for SOT1369-5 (HVQFN40); I/O pads and solderable area

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver



© NXP B.V.	ALL RIGHTS RESERVED		DATE: 2	0 SEP 2019
MECHANICAL OUTLINE	STANDARD:	DRAWING NUMBER:	REVISION:	
PRINT VERSION NOT TO SCALE	NON-JEDEC	98ASA01371D	0	

Figure 27. PCB footprint for SOT1369-5 (HVQFN40); solder paste stencil

## 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# 19 Abbreviations

Table 32. Abbreviations

Acronym	Description
CDM	Charged-Device Model
DAC	Digital-to-Analog Converter
DUT	Device Under Test
ESD	ElectroStatic Discharge
FET	Field-Effect Transistor
НВМ	Human Body Model
LED	Light Emitting Diode
LSB	Least Significant Bit
MCU	MicroController Unit
MISO	Master In, Slave Out
MOSI	Master Out, Slave In
MSB	Most Significant Bit
NMOS	Negative-channel Metal-Oxide Semiconductor
РСВ	Printed-Circuit Board
PMOS	Positive-channel Metal-Oxide Semiconductor
PWM	Pulse Width Modulation
RGB	Red/Green/Blue
RGBA	Red/Green/Blue/Amber
SMBus	System Management Bus
SPI	Serial Peripheral Interface

# 20 Revision history

Table 33. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
PCA9957 v.2.1	20211022	Product data sheet	2021100251	PCA9957 v.2.0			
Modifications:		<ul> <li>Table 3: Updated description for CS</li> <li>Section 8.1: Updated SDO information in sections CS and SDO</li> </ul>					
PCA9957 v.2.0	20210225	Product data sheet	-	PCA9957 v.1.0			
Modifications:	<ul> <li>Section 7.2.13 channels" to "if</li> <li>Section 7.2.9 "Cinformation for</li> </ul>	<ul> <li>Added V<sub>trip</sub> minimum of 1.85 V</li> <li>Section 7.2.13 "LED error detection": Corrected "if there is a fault condition in any of the 16 channels" to "if there is a fault condition in any of the 24 channels"</li> <li>Section 7.2.9 "OFFSET — LEDn output delay offset register": Updated register description information for bits 3:0</li> <li>Section 13 "Dynamic characteristics": Added OE pin enable/disable min time and chart</li> </ul>					
PCA9957 v.1.0	20191024	Product data sheet	-	-			

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

## 21 Legal information

#### 21.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="https://www.nxp.com">https://www.nxp.com</a>.

#### 21.2 Definitions

**Draft** — A draft status on a document indicates that the content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included in a draft version of a document and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

#### 21.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

PCA9957

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2021. All rights reserved.

#### 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Suitability for use in non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

**Translations** — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

Security — Customer understands that all NXP products may be subject to unidentified vulnerabilities or may support established security standards or specifications with known limitations. Customer is responsible for the design and operation of its applications and products throughout their lifecycles to reduce the effect of these vulnerabilities on customer's applications and products. Customer's responsibility also extends to other open and/or proprietary technologies supported by NXP products for use in customer's applications. NXP accepts no liability for any vulnerability. Customer should regularly check security updates from NXP and follow up appropriately. Customer shall select products with security features that best meet rules, regulations, and standards of the intended application and make the ultimate design decisions regarding its products and is solely responsible for compliance with all legal, regulatory, and security related requirements concerning its products, regardless of any information or support that may be provided by NXP.

NXP has a Product Security Incident Response Team (PSIRT) (reachable at <a href="PSIRT@nxp.com">PSIRT@nxp.com</a>) that manages the investigation, reporting, and solution release to security vulnerabilities of NXP products.

#### 21.4 Trademarks

Notice: All referenced brands, product names, service names, and trademarks are the property of their respective owners.

NXP — wordmark and logo are trademarks of NXP B.V.

## 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

# **Tables**

Iab. 1.	Ordering information			4Bh, 4Fh, 53h, 57h) for each group bit	40
Tab. 2.	Ordering options		T-h 10	description	19
Tab. 3.	Pin description		Tab. 16.	GRAD_MODE_SEL[0:1] - Gradation mode	
Tab. 4.	Register summary - default values	/		select register for channel 23 to channel 0	
Tab. 5.	MODE1 - Mode register 1 (address 00h) bit			(address 58h, 59h, 5Ah) bit description	20
	description	11	Tab. 17.	GRAD_GRP_SEL[0:3] - Gradation group	
Tab. 6.	MODE2 - Mode register 2 (address 01h) bit			select register for channel 23 to channel	
	description	11		0 (address 5Bh, 5Ch, 5Dh, 5Eh, 5Fh,	
Tab. 7.	LEDOUT0 to LEDOUT5 - LED driver output			60h, 61h, 62h, 63h, 64h, 65h, 66h) bit	
	state registers (address 08h to 0Dh) bit			description	20
	description	12	Tab. 18.	GRAD_CNTL[0:1] - Gradation control	
Tab. 8.	GRPPWM - Group brightness control			register for group 5 to group 0 (address	
	register (address 0Eh) bit description	14		67h, 68h) bit description	22
Tab. 9.	GRPFREQ - Group frequency register		Tab. 19.	OFFSET - LEDn output delay offset	
	(address 0Fh) bit description	.14		register (address 69h) bit description	25
Tab. 10.	PWM0 to PWM23 - PWM registers 0 to 23		Tab. 20.	PWMALL - brightness control for all	
	(address 10h to 27h) bit description	14		LEDn outputs register (address 6Ah) bit	
Tab. 11.	IREF0 to IREF23 - LED output gain			description	26
	control registers (address 28h to 3Fh) bit		Tab. 21.	IREFALL - Output gain control for all LED	
	description	16		outputs (address 6Bh) bit description	27
Tab. 12.	RAMP_RATE_GRP[0:3] - Ramp enable		Tab. 22.	EFLAG0 to EFLAG5 - Error flag registers	
	and rate control registers (address 40h,			(address 02h to 07h) bit description	29
	44h, 48h, 4Ch, 50h, 54h) for each group bit		Tab. 23.	ERRx bit description	
	description	18	Tab. 24.	Open-circuit detection	
Tab. 13.	STEP TIME GRP[0:3] - Step time control		Tab. 25.	Short-circuit detection	
	registers (address 41h, 45h, 49h, 4Dh, 51h,		Tab. 26.	Limiting values	38
	55h) for each group bit description	18	Tab. 27.	Thermal characteristics	
Tab. 14.	HOLD_CNTL_GRP[0:3] - Hold ON and		Tab. 28.	Static characteristics	
	OFF enable and time control registers		Tab. 29.	Dynamic characteristics	
	(address 42h, 46h, 4Ah, 4Eh, 52h, 56h) for		Tab. 30.	SnPb eutectic process (from J-STD-020D)	
	each group bit description	19	Tab. 31.	Lead-free process (from J-STD-020D)	
Tab. 15.	IREF_GRP[0:3] - Final and hold ON output		Tab. 32.	Abbreviations	
	gain setting registers (address 43h, 47h,		Tab. 33.	Revision history	
Figur	es				
Fig. 1.	Block diagram of PCA9957		Fig. 17.	Typical application	
Fig. 2.	Pin configuration for HVQFN40	5	Fig. 18.	Definition of timing	
Fig. 3.	Register address and data format for each		Fig. 19.	OE pin timing	
	slave		Fig. 20.	Test circuitry for switching times	42
Fig. 4.	Linear and exponential adjustment curves	12	Fig. 21.	Package outline SOT1369-5 (HVQFN40) (1	
Fig. 5.	Gradation timing	17		of 3)	43
Fig. 6.	Ramp calculation example 1	23	Fig. 22.	Package outline SOT1369-5 (HVQFN40) (2	
Fig. 7.	Ramp calculation example 2	24		of 3)	44
Fig. 8.	Gradation output waveform in single shot		Fig. 23.	Package outline SOT1369-5 (HVQFN40) (3	
	or continuous mode			of 3)	45
Fig. 9.	Maximum ILED versus Rext	28	Fig. 24.	Temperature profiles for large and small	
Fig. 10.	IO(target) versus IREFx value with Rext = 2			components	48
-	kΩ	28	Fig. 25.	PCB footprint for SOT1369-5 (HVQFN40);	
Fig. 11.	Brightness + Group Dimming signals		•	solder mask opening pattern	49
Fig. 12.	System level connection		Fig. 26.	PCB footprint for SOT1369-5 (HVQFN40);	
Fig. 13.	Data format		Ü	I/O pads and solderable area	50
Fig. 14.	Write access		Fig. 27.	PCB footprint for SOT1369-5 (HVQFN40);	
Fig. 15.	Read access	35	Ü	solder paste stencil	51
Fig. 16.	Overlapped read and write access			•	
-				O 100 D 11 COOK AT THE COOK AT	
PCA9957	All information provided in	ınıs docum	ent is subject to lega	al disclaimers. © NXP B.V. 2021. All rights re-	served.

**NXP Semiconductors** 

## 24-channel SPI serial bus 32 mA/5.5 V constant current LED driver

7.6

8

8.1

8.2 8.3 8.4 8.5

## **Contents**

1	General description1
2	Features and benefits2
3	
-	Applications
4	Ordering information3
4.1	Ordering options
5	Block diagram4
6	Pinning information5
6.1	Pinning5
6.2	Pin description5
7	Functional description6
7.1	Register address and data6
7.2	Register definitions7
7.2.1	MODE1 — Mode register 111
7.2.2	MODE2 — Mode register 211
7.2.3	LEDOUT0 to LEDOUT5, LED driver output
	state12
7.2.4	GRPPWM, group duty cycle control14
7.2.5	GRPFREQ, group frequency14
7.2.6	PWM0 to PWM23, individual brightness
1.2.0	control14
7.2.7	IREF0 to IREF23, LED output current value
1.2.1	registers15
7.2.8	Gradation control
7.2.8.1	RAMP_RATE_GRP0 to RAMP_RATE_
7000	GRP5, ramp rate control registers
7.2.8.2	STEP_TIME_GRP0 to STEP_TIME_GRP5,
	step time control registers
7.2.8.3	HOLD_CNTL_GRP0 to HOLD_CNTL_
	GRP5, hold ON and OFF control registers 19
7.2.8.4	IREF_GRP0 to IREF_GRP5, output gain
	control19
7.2.8.5	GRAD_MODE_SEL0 to GRAD_MODE_
	SEL2, Gradation mode select registers 20
7.2.8.6	GRAD_GRP_SEL0 to GRAD_GRP_SEL11,
	Gradation group select registers20
7.2.8.7	GRAD_CNTL, Gradation control register22
7.2.8.8	Ramp control — equation and calculation
	example23
7.2.9	OFFSET — LEDn output delay offset
	register25
7.2.10	PWMALL — brightness control for all LEDn
1.2.10	outputs26
7.2.11	IREFALL register: output current value for
1.2.11	all LED outputs27
7.2.12	LED driver constant current outputs
7.2.12	
7.2.12.1	· ·j
	LED error detection
7.2.13.1	· · · · · · · · · · · · · · · · · · ·
7.2.13.2	· · · · · · · · · · · · · · · · · · ·
7.2.14	Overtemperature protection31
7.3	Active LOW output enable input31
7.4	Power-on reset31
7.5	Hardware reset recovery31

Individual brightness control with group	
dimming/blinking	31
Characteristics of the 4-wire SPI serial-bus	
interface	32
SPI-compatible 4-wire serial interface	
signals	32
Data format	33
Write access sequence	34
Read access sequence	
Overlapped read and write access	
sequence	35
Application design-in information	
Thermal considerations	36
Limiting values	
Thermal characteristics	38
Static characteristics	
Dynamic characteristics	40
Test information	
Package outline	
Handling information	
Soldering of SMD packages	46
Introduction to soldering	
Wave and reflow soldering	
Wave soldering	
Reflow soldering	
Soldering: PCB footprints	49
Abbreviations	_
Revision history	
Legal information	53

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

NXP:

PCA9957HNMP